

# Advanced Power Electronics and Electric Machines

**Gilbert Moreno and Sreekant Narumanchi**  
**Advanced Power Electronics and Electric Machines Group**  
**Center for Integrated Mobility Sciences**  
**National Renewable Energy Laboratory**

**Lecture at the University of Toronto**  
**April 6, 2022**

# Seminar/Lecture Outline

- **4:15 – 4:45 p.m. Eastern:** Overview of Advanced Power Electronics and Electric Machines Electro-thermal, Thermal-Fluids, Thermo-mechanical, and Reliability Research at NREL (Sreekant)
- **4:45 - 5:05 p.m.:** Thermal Management of Power Electronics (Gilbert)
- **5:05 -5:15 p.m.:** Break
- **5:15 – 5:55 p.m.:** Thermal Management of Power Electronics (Gilbert) - continued
- **5:55 – 6:10 p.m.:** Power Electronics Materials and Component Reliability (Sreekant)
- **6:10 – 6:20 p.m.:** Break
- **6:20 – 6:35 p.m.:** Thermal Management of Electric Machines and Integrated Electric Drive Systems (Sreekant)





# Overview of Advanced Power Electronics and Electric Machines Electro-thermal, Thermal-Fluids, Thermo-mechanical, and Reliability Research at NREL

**Sreekant Narumanchi**

Group/Center Members: Kevin Bennion, Diane Bock, Emily Cousineau, Doug DeVoto, Xuhui Feng, Bidzina Kekelia, Brian Kelly, Faisal Khan, Ram Kotecha, Josh Major, Gilbert Moreno, Paul Paret, Jeff Tomerlin

# U.S. Department of Energy Laboratories

## Office of Science Laboratories

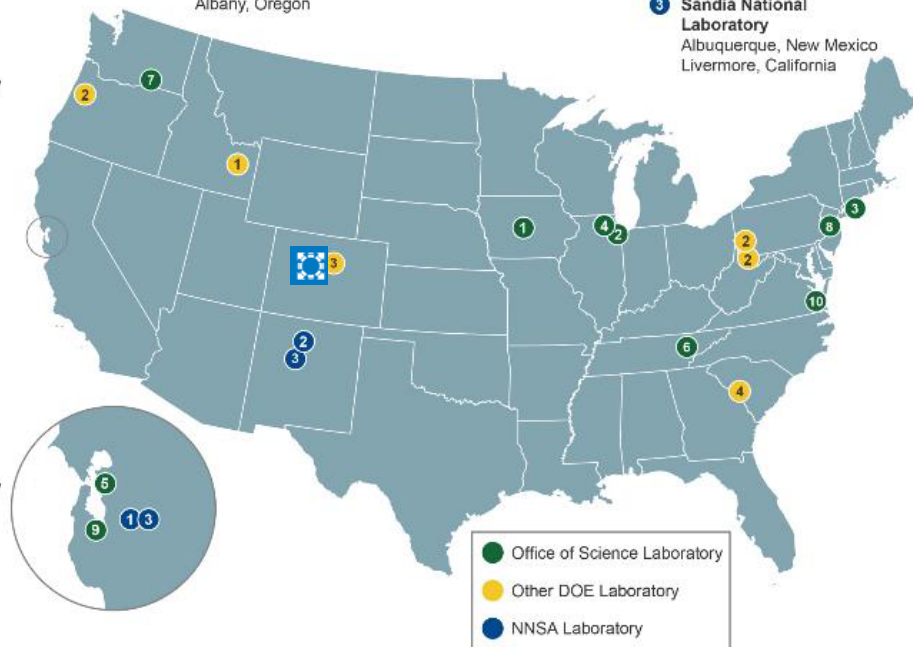
- 1 Ames Laboratory  
Ames, Iowa
- 2 Argonne National Laboratory  
Argonne, Illinois
- 3 Brookhaven National Laboratory  
Upton, New York
- 4 Fermi National Accelerator Laboratory  
Batavia, Illinois
- 5 Lawrence Berkeley National Laboratory  
Berkeley, California
- 6 Oak Ridge National Laboratory  
Oak Ridge, Tennessee
- 7 Pacific Northwest National Laboratory  
Richland, Washington
- 8 Princeton Plasma Physics Laboratory  
Princeton, New Jersey
- 9 SLAC National Accelerator Laboratory  
Menlo Park, California
- 10 Thomas Jefferson National Accelerator Facility  
Newport News, Virginia

## Other DOE Laboratories

- 1 Idaho National Laboratory  
Idaho Falls, Idaho
- 2 National Energy Technology Laboratory  
Morgantown, West Virginia  
Pittsburgh, Pennsylvania  
Albany, Oregon
- 3 National Renewable Energy Laboratory  
Golden, Colorado
- 4 Savannah River National Laboratory  
Aiken, South Carolina

## NNSA Laboratories

- 1 Lawrence Livermore National Laboratory  
Livermore, California
- 2 Los Alamos National Laboratory  
Los Alamos, New Mexico
- 3 Sandia National Laboratory  
Albuquerque, New Mexico  
Livermore, California



# National Renewable Energy Laboratory



Leading clean energy  
innovation for 45  
years



3,000 employees  
with world-class  
facilities



Campus is a living  
model of sustainable  
energy



Owned by the U.S.  
Department of  
Energy (DOE)



Operated by the  
Alliance for  
Sustainable Energy



# Scope of NREL's Mission

## Sustainable Transportation

Vehicles/  
Mobility

Hydrogen

Biofuels

## Energy Productivity

Residential  
Buildings

Commercial  
Buildings

Manufacturing

## Renewable Electricity

Solar

Wind

Water: Marine  
Hydrokinetics

Geothermal

## Systems Integration

Grid Integration  
of Clean Energy

Distributed  
Energy Systems

Batteries and  
Thermal Storage

Energy Analysis

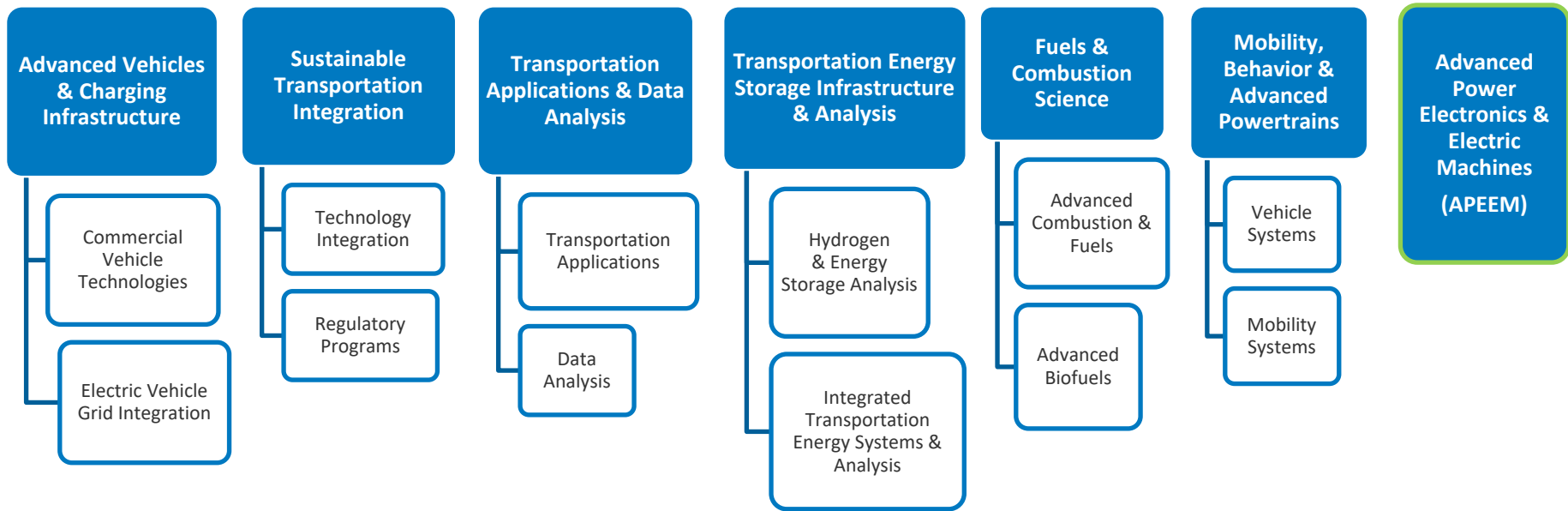
## Partnerships

Private Industry

Federal  
Agencies

State/Local  
Government

International

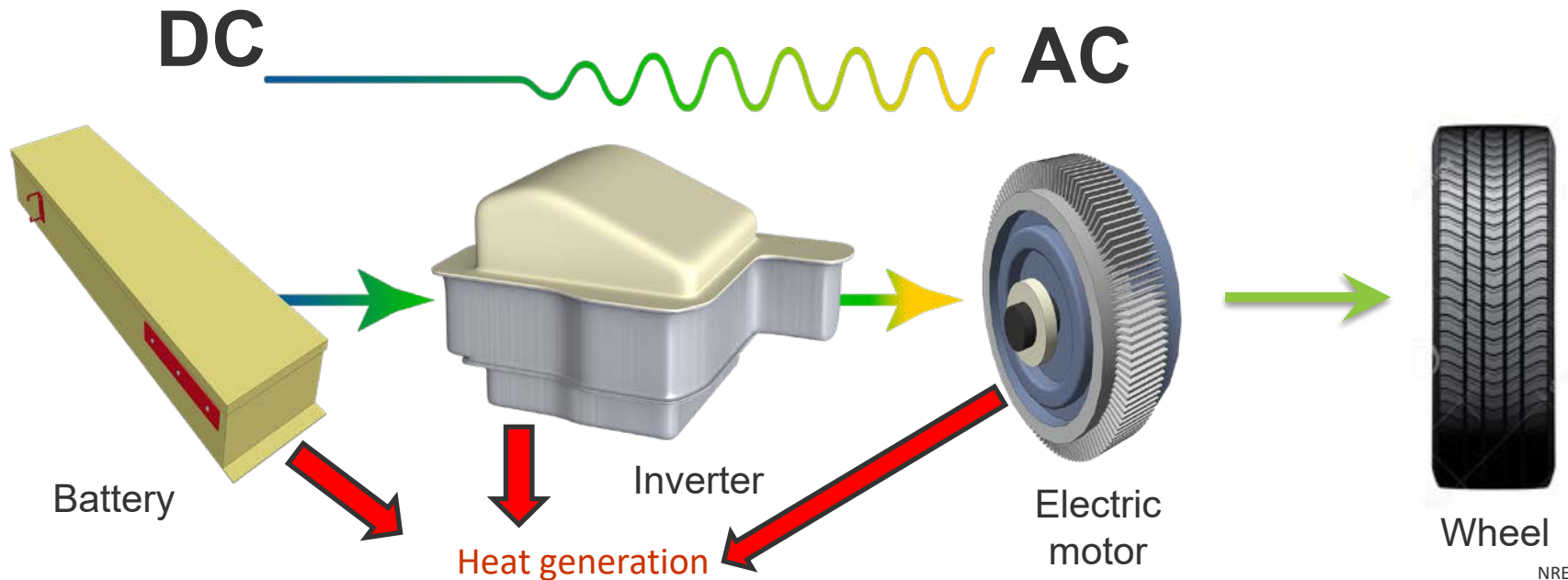


## Center for Integrated Mobility Sciences (CIMS)

APEEM Group: Twelve (12) staff members involved in electro-thermal, thermal-fluids, thermo-mechanical, and reliability research activities.

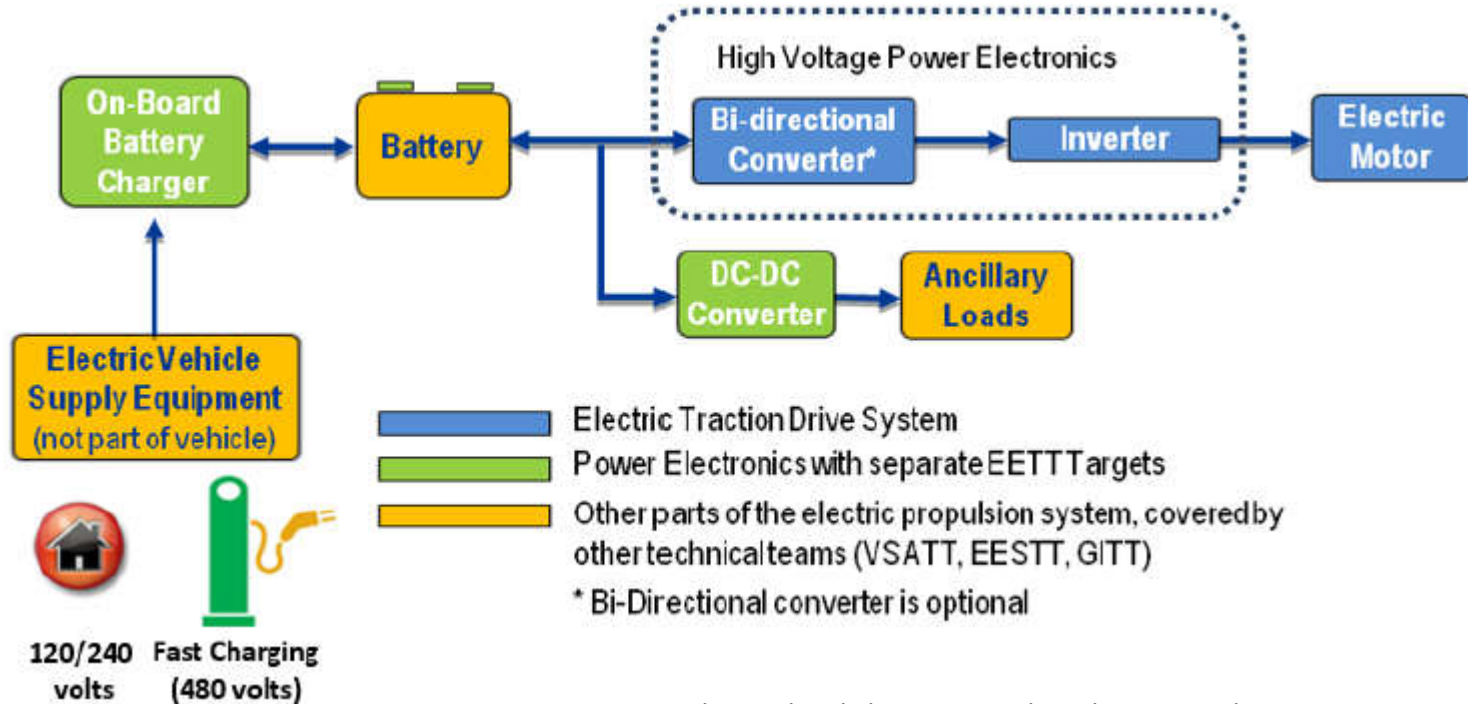
# Electric Traction Drive – Basic Functionality

- Inverter: Converts direct current (DC) from the battery to alternating current (AC) for the electric motor.
- Electric motor: Power to the wheels.





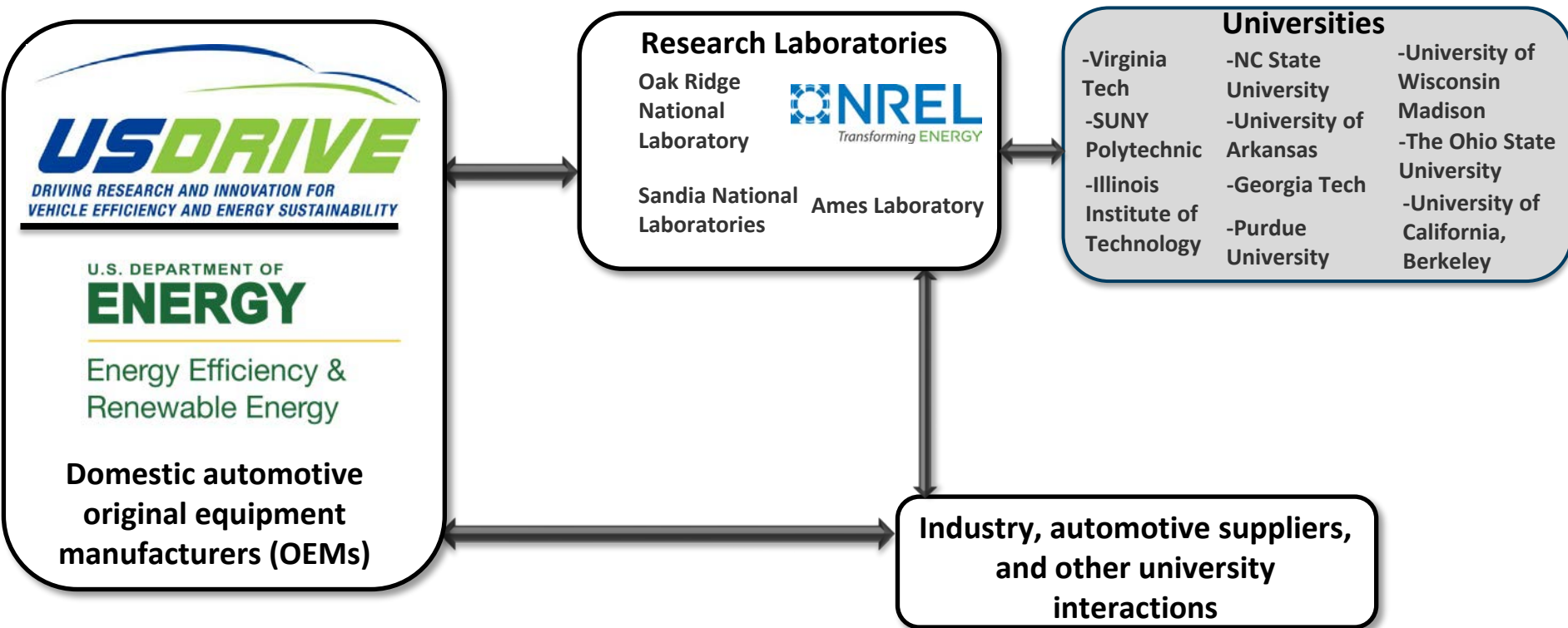
# Electric Traction Drive System



Source: U.S. DRIVE. 2017. *Electrical and Electronics Technical Team Roadmap*.

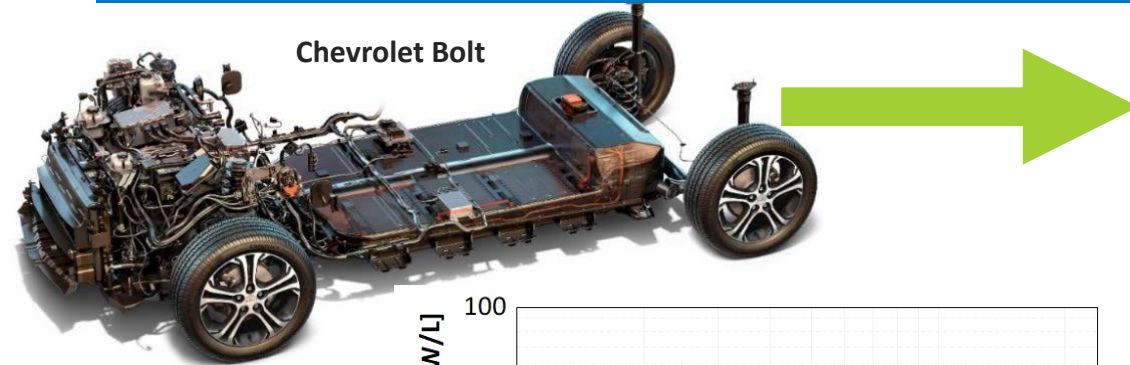
<https://www.energy.gov/sites/prod/files/2017/11/f39/EETT%20Roadmap%2010-27-17.pdf>.

# DOE Vehicle Technologies Office (VTO) Electric Drive Technologies (EDT) Program

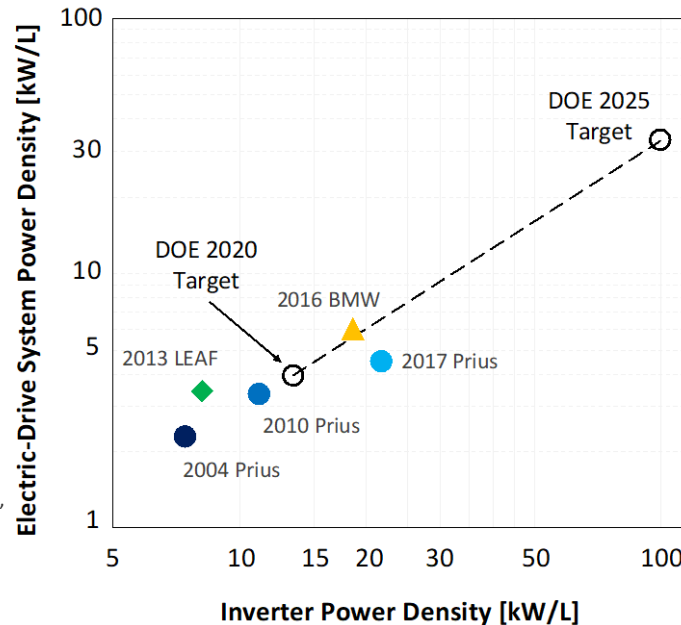


Source: U.S. DRIVE. 2017. *Electrical and Electronics Technical Team Roadmap*.  
<https://www.energy.gov/sites/prod/files/2017/11/f39/EETT%20Roadmap%2010-27-17.pdf>.

# VTO EDT Research Pathway for Electric-Drive Vehicle Electrification



Future mobility design concept

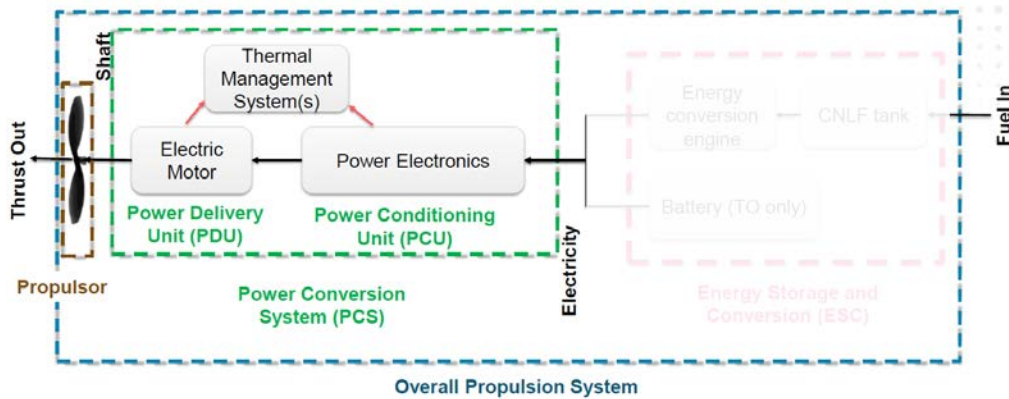


2025 Electric Traction Drive System Targets	
Cost	\$6/kW (50% reduction)
Power Density	33 kW/L (850% increase)
Power Level	100 kW
Reliability/Lifetime	300,000 miles (100% increase)

Source: U.S. DRIVE. 2017. *Electrical and Electronics Technical Team Roadmap*. <https://www.energy.gov/sites/prod/files/2017/11/f39/EETT%20Roadmap%2010-27-17.pdf>.

Source: M. Muratori, M. Alexander, D. Arent, M. Bazilian, E. Dede, J. Farrell, C. Gearhart, et al. 2021. "The Rise of Electric Vehicles – 2020 Status and Future Expectations." *Progress in Energy* 3 (2), 022002.

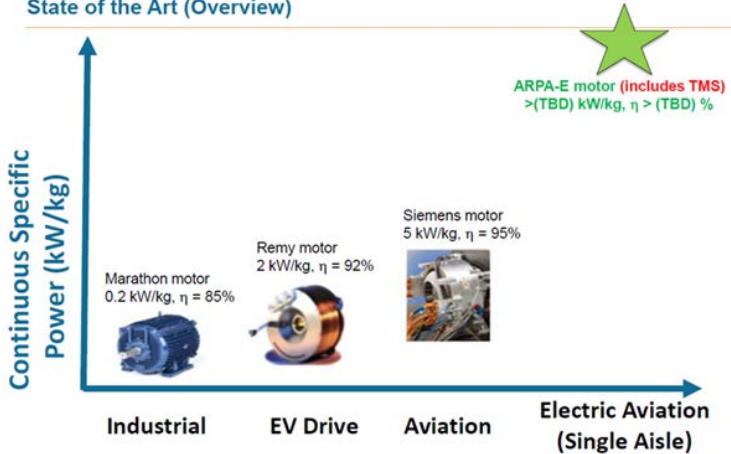
# Advanced Research Projects Agency – Energy (ARPA-E) Electric Drive Efforts



## ASCEND Solicitation

Source: Overview Presentation by Michael Ohadi at the ARPA-E Workshop on Electrified Aviation, August 2019, Arlington, VA.

### State of the Art (Overview)



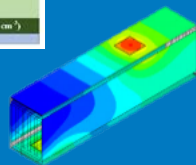
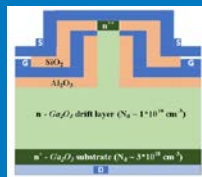
**Boeing B737-MAX 8**  
 Range: 6,570 km  
 MTOW: 82,191 kg  
 Take-off thrust: 130.4 kN

Single-aisle (narrow-body): 100 – 200 passengers

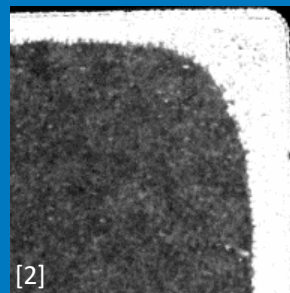


# NREL APEEM Group Research Focus Areas

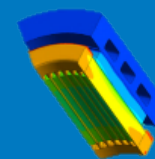
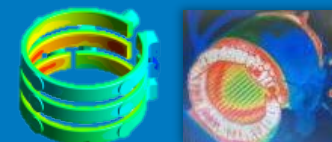
## Power Electronics Thermal and Electrothermal



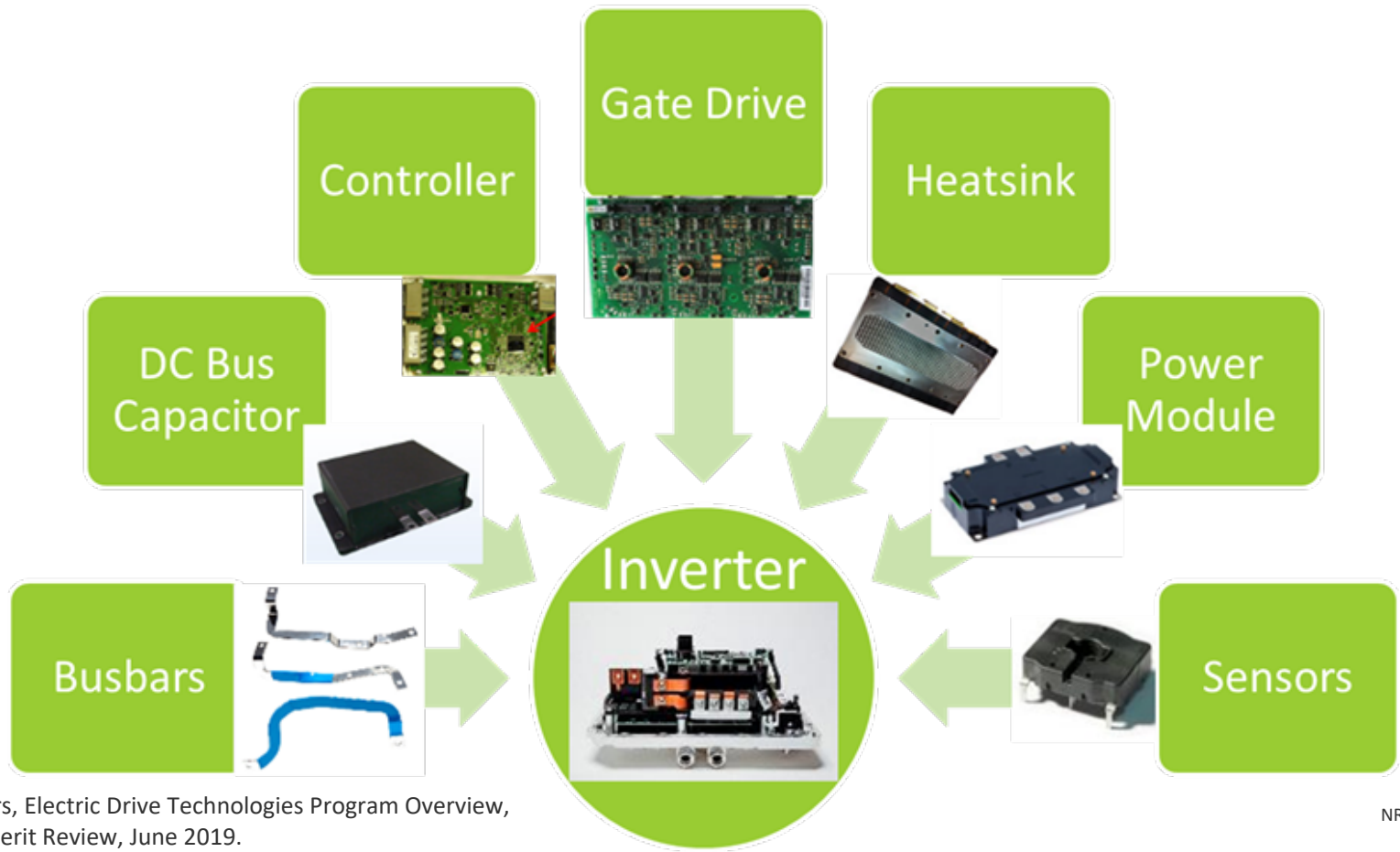
## Advanced Packaging Designs and Reliability



## Electric Motor Thermal Management

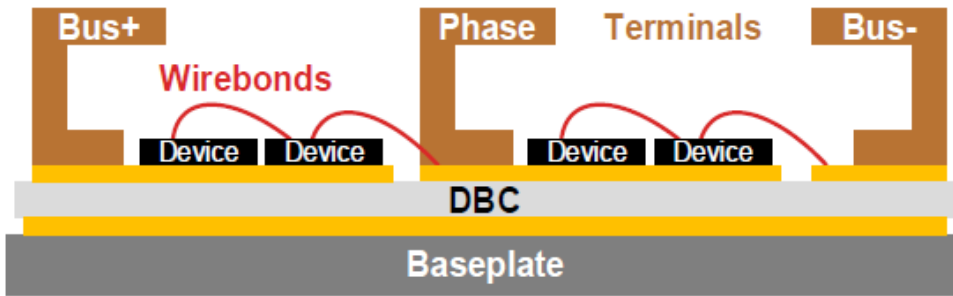


# Inverter – Constituents

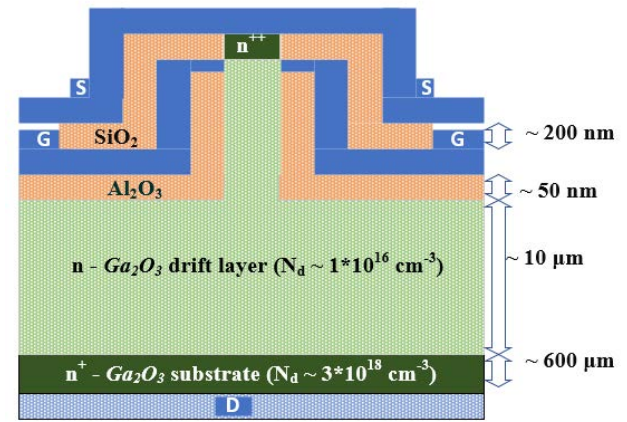


# Power Electronics: Semiconductor Device and Package Research

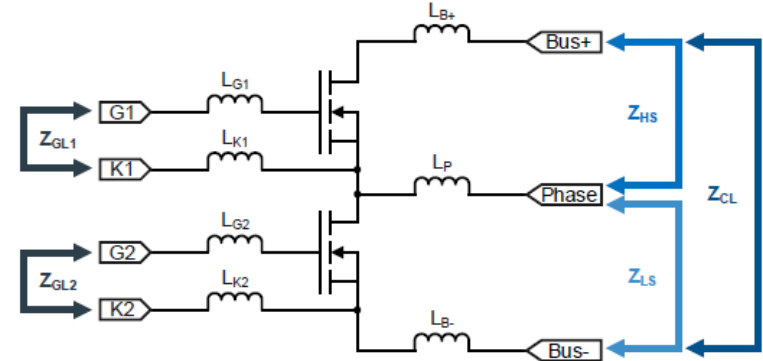
- Semiconductor modeling research for wide-bandgap (WBG) and ultrawide-bandgap (UWBG) devices.
- Electrical and electromagnetic design for power electronics packages.



Multi-chip power module



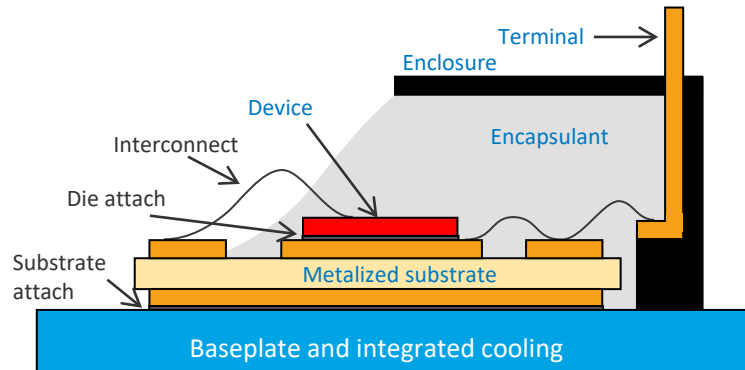
Micro-nanoscale device modeling



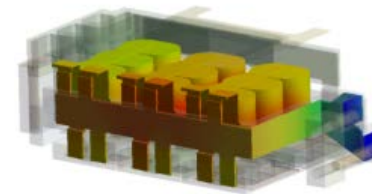
Equivalent circuit of extracted package

# Power Electronics Thermal and Electrothermal Research Pathway

- Compact, power-dense WBG-device-based power electronics
  - Higher-temperature-rated devices, components, and materials
  - Advanced heat transfer technologies
  - System-level thermal management.



Advanced cooling

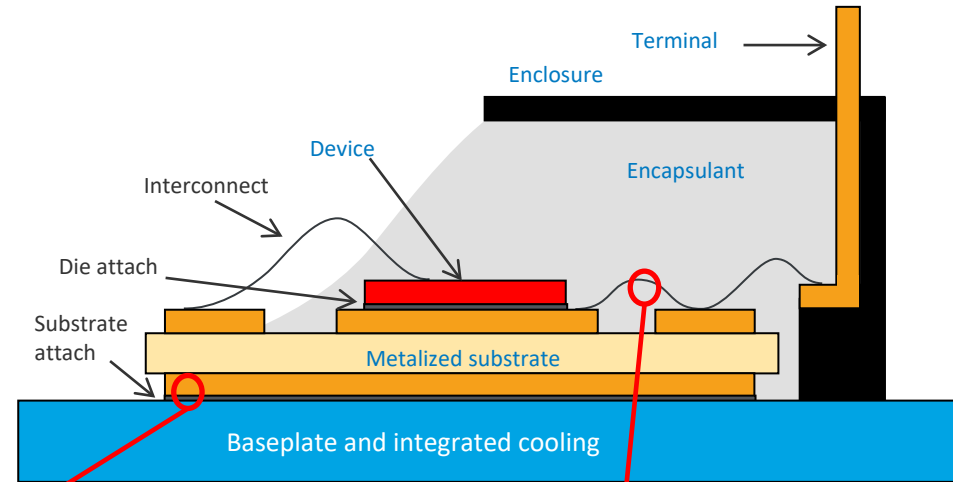


Component-level and system-level heat transfer



# Advanced Power Electronics Packaging Performance and Reliability – Research Pathway

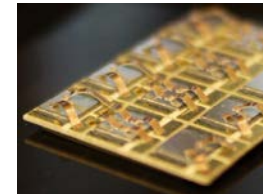
- Improve reliability of new (high-temperature/WBG) technologies
- Develop predictive and remaining lifetime models
- Package parametric modeling



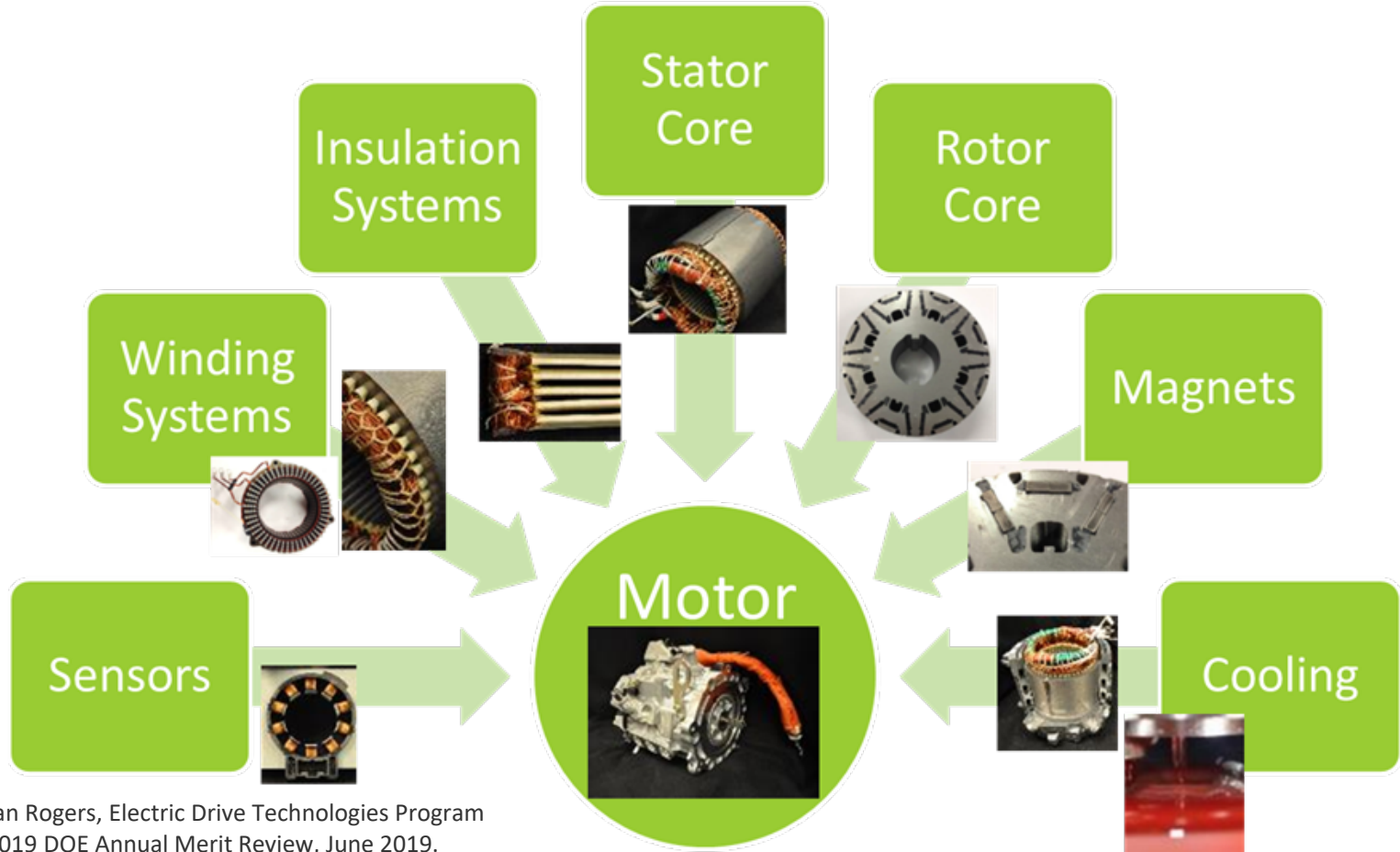
Bonded interface



Electrical interconnects



# Electric Motor – Constituents

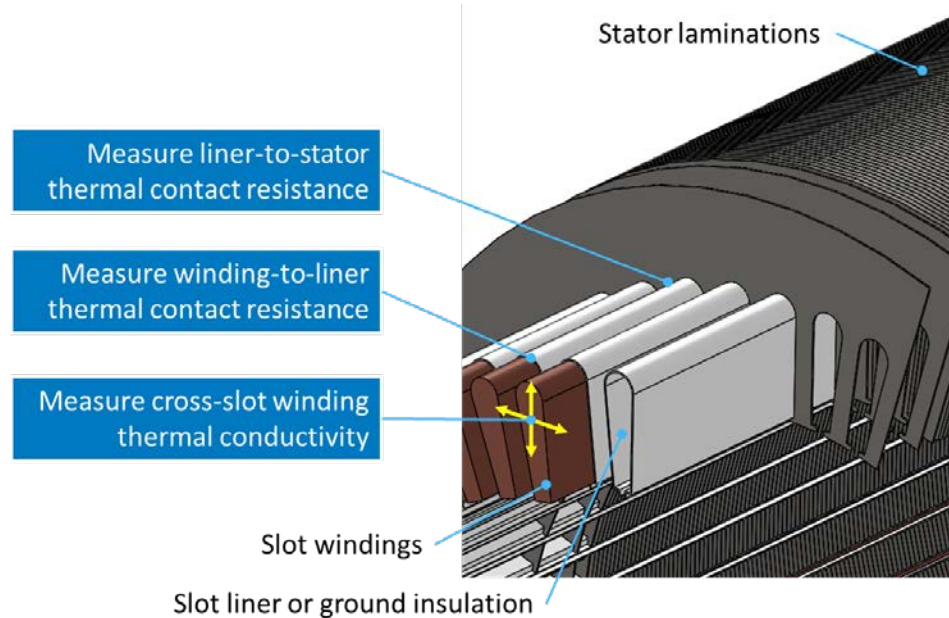


# Electric Motor Thermal Management – Research Pathway

- Understand and evaluate material and interface properties as a function of temperature.
- Develop and evaluate advanced fluid-based cooling strategies.
- Use modeling to guide advanced motor design and development.

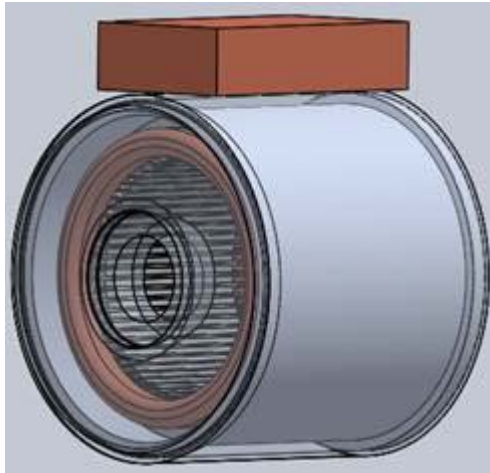


Image credit: Bidzina Kekelia (NREL)

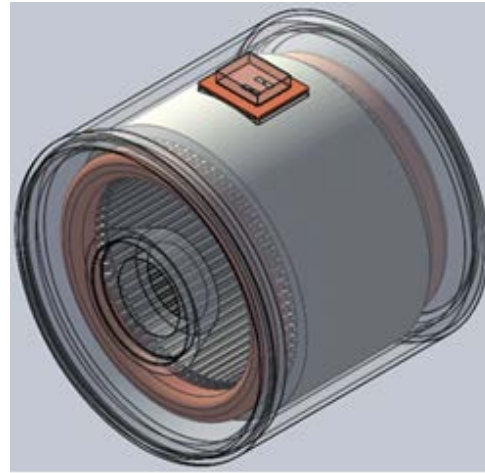


# Integrated Traction Drive System

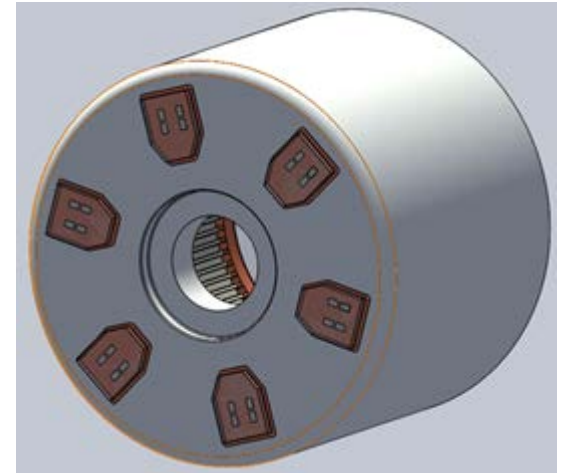
## Different integration techniques



Separate enclosures



Radial integration



Axial integration



# Thermal-fluids and Electro-thermal Capabilities

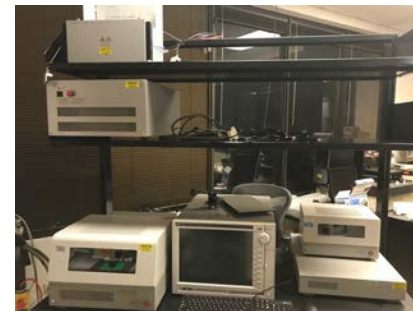
## Laboratory Resources



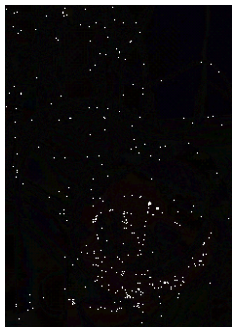
Single-phase liquid loops



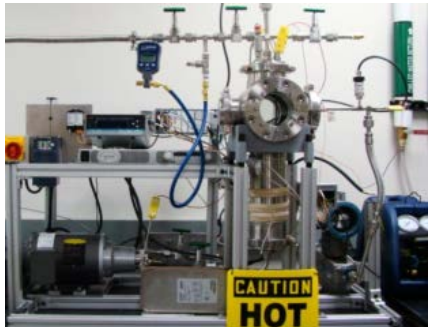
Air cooling loops



Power device analyzer



Two-phase liquid loops



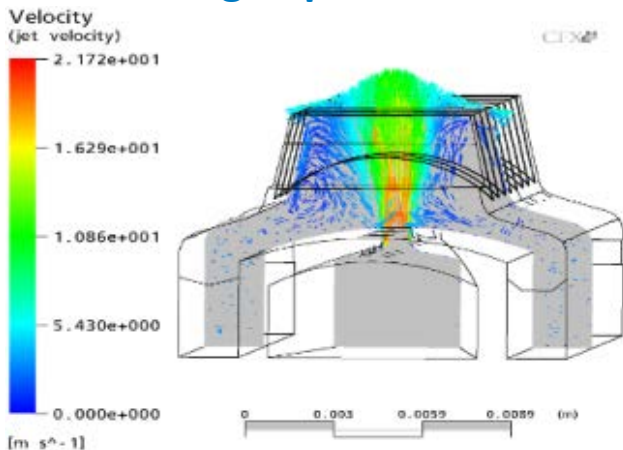
Transient thermal tester



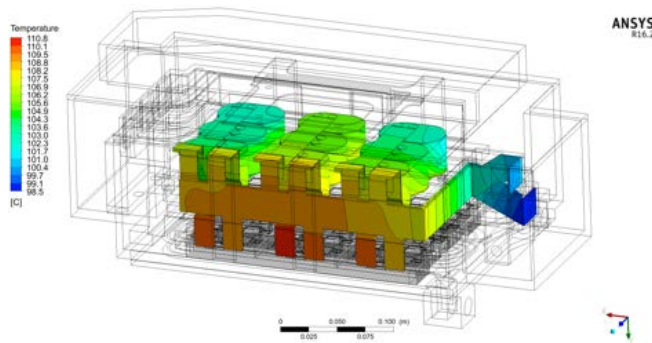
Material thermal resistance  
characterization

# Thermal-fluids and Electro-thermal Capabilities

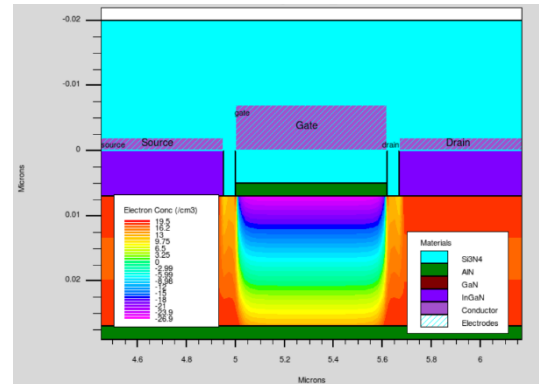
## Modeling Capabilities



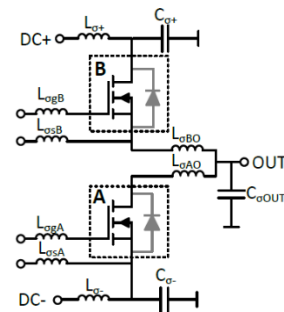
Single-phase computational fluid dynamics



Thermal finite element analysis



Power device electrothermal finite element analysis



Module parasitics extraction and modeling

# Prototype Fabrication Capabilities

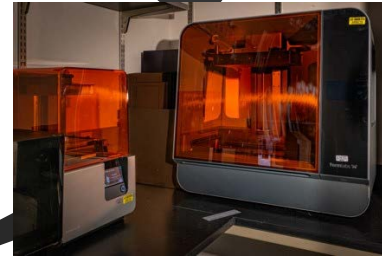
CNC router



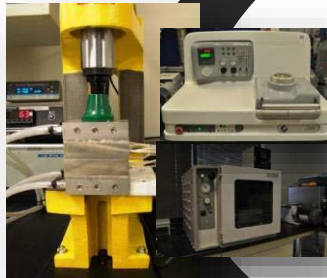
Waterjet cutter



SLA printer

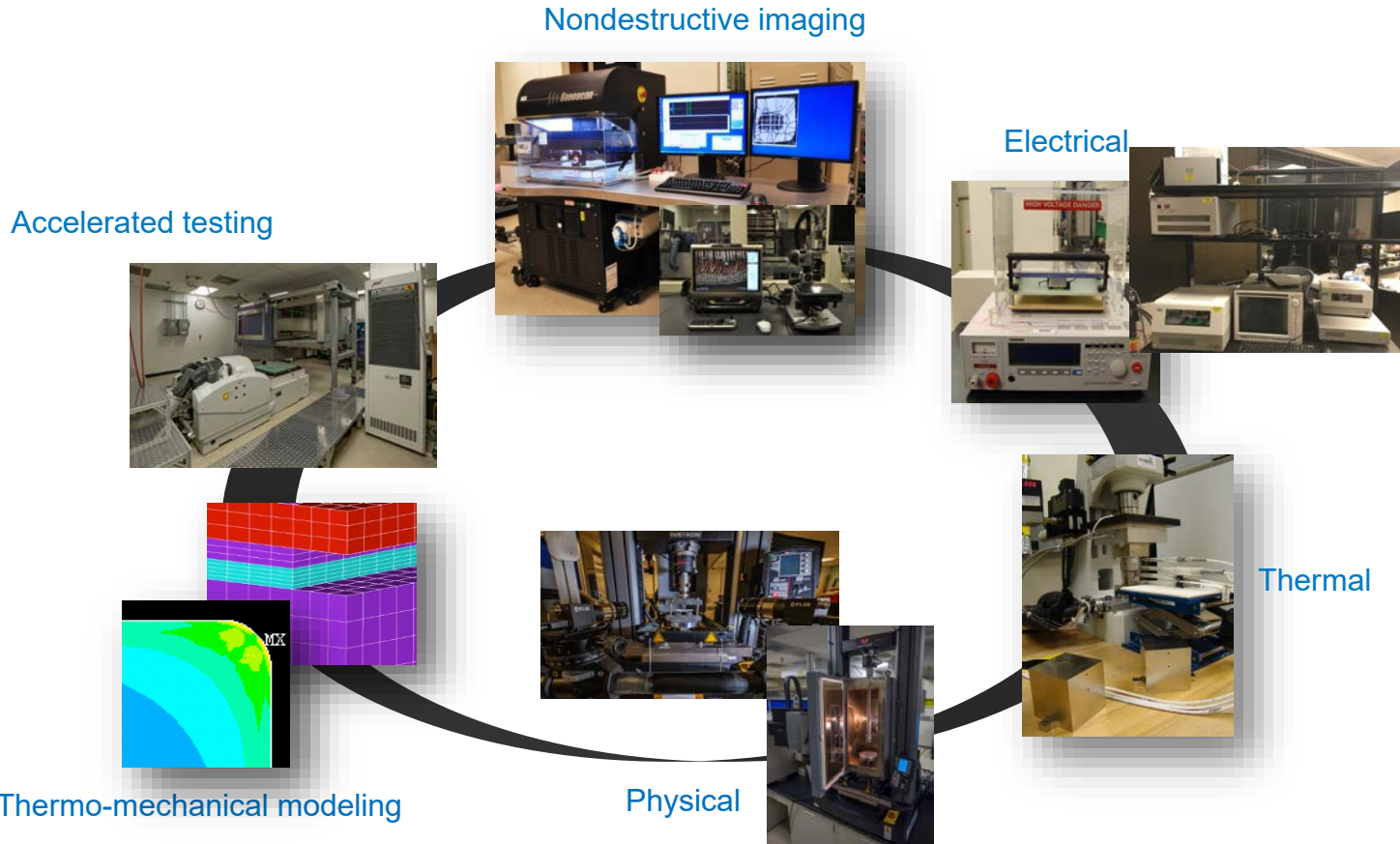


Synthesis of bonded interfaces



Wire bonder

# Thermo-mechanical Reliability Capabilities



# How To Work With NREL

Visit: <https://www.nrel.gov/workingwithus/technology-partnership-agreements.html>

- Shared resources collaborations (DOE EDT projects)
- Cooperative research and development agreements (CRADAs)
  - Shared resources
  - Funds-in agreements
- Technology partnership projects
  - Interagency agreement
  - Funds-in agreement
  - Technical services agreement
- Teaming in response to lab calls, solicitations, and calls for proposals



# More Information

## Acknowledgments:

- U.S. Department of Energy (DOE)
- EDT Program, DOE Vehicle Technologies Office
- DOE Advanced Manufacturing Office
- ARPA-E

## For more information, contact:

### **CIMS APEEM Group Manager**

Sreekant Narumanchi

sreekant.narumanchi@nrel.gov

Phone: (303) 275-4062

## Industry and Research Partners and Collaborators

Industry OEMs	Ford, GM, John Deere, Toyota, Caterpillar, Cummins, Daimler
Suppliers/other industry	3M, NBETech, Curamik, DuPont, General Electric (Global Research Center, GE Aviation), Semikron, Kyocera, Sapa, Delphi, BorgWarner, ADA Technologies, Heraeus, Henkel, Wolverine Tube Inc., Wolfspeed, Indiana IC, Momentive, Kulicke & Soffa, UQM Technologies, nGimat LLC, Synteris, Packet Digital
Agencies	DARPA, U.S. Army
National/government laboratories	Oak Ridge National Laboratory, Ames Laboratory, Argonne National Laboratory, Sandia National Laboratories, U.S. Army Research Laboratory
Universities	Virginia Tech, University of Colorado Boulder, University of Wisconsin, Carnegie Mellon University, Texas A&M University, North Carolina State University, The Ohio State University, Florida State University, Georgia Tech, University of Missouri Kansas City, North Dakota State University, University of Arkansas, University of Maryland, University of Tennessee, Stanford University



# Thermal Management of Power Electronics

Gilbert Moreno

# Automotive Power Electronics Cooling Roadmap: Current Status

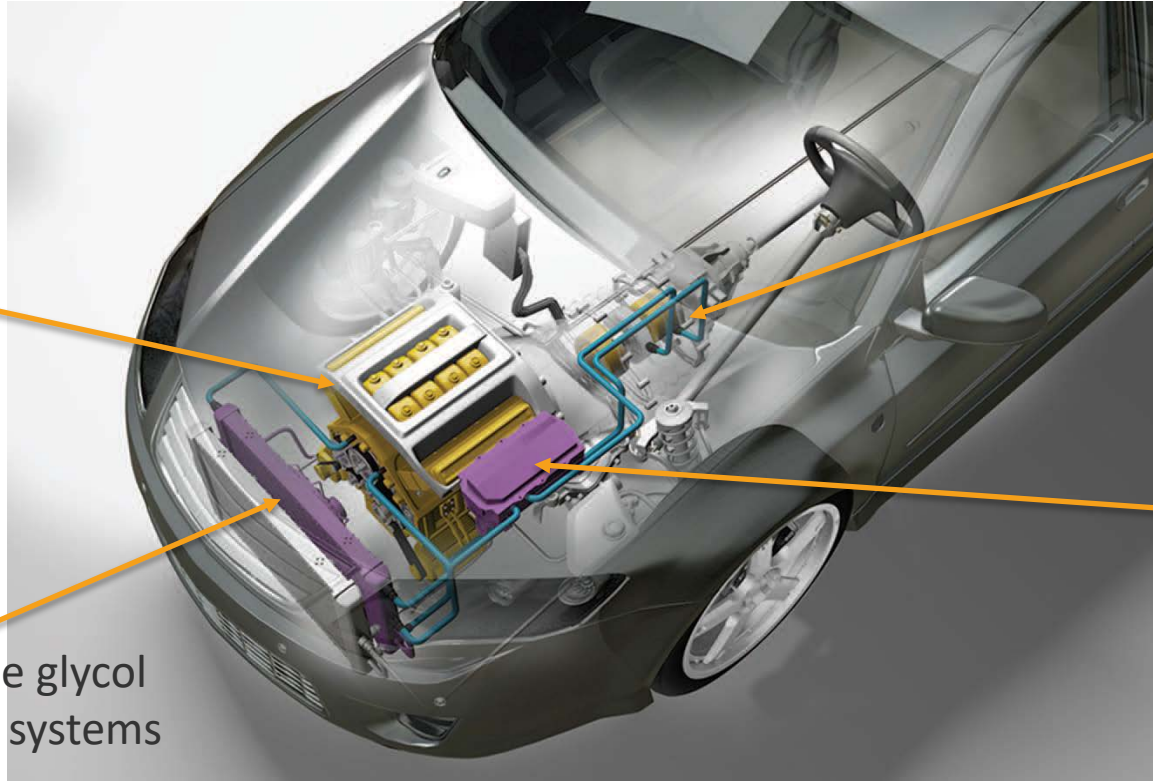
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# Electric-Drive Vehicle Coolant Systems

## Hybrid electric vehicle

Internal combustion engine

Electric motor(s)



Water-ethylene glycol (WEG) cooling systems

Power electronics

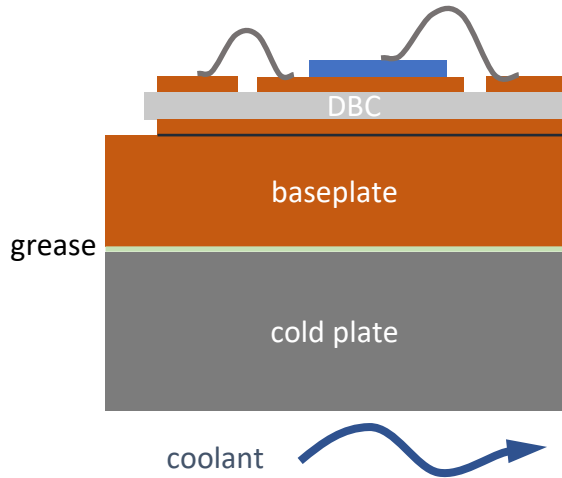


Image credit: Xuhui Feng, NREL

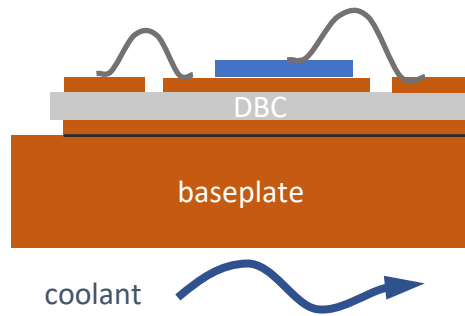
# Typical Power Module Configurations

## Single-side cooled

Cold plate cooled

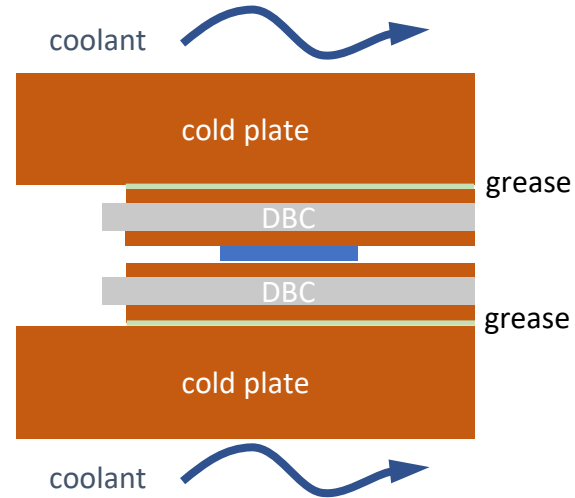


Baseplate cooled



## Double-side cooled

coolant

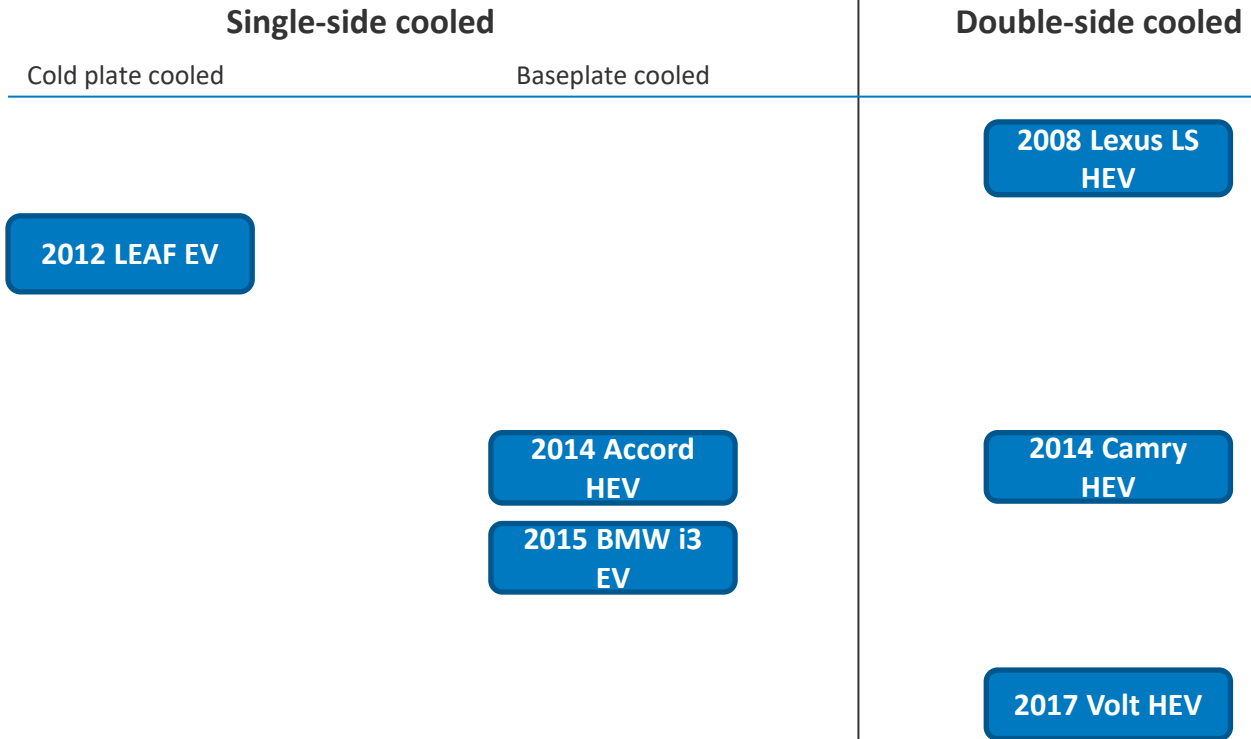


Automotive power electronics cooling trend

Variations for each cooling configuration exist



# Typical Power Module Configurations



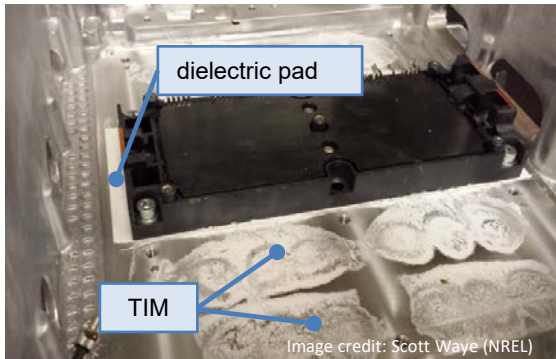
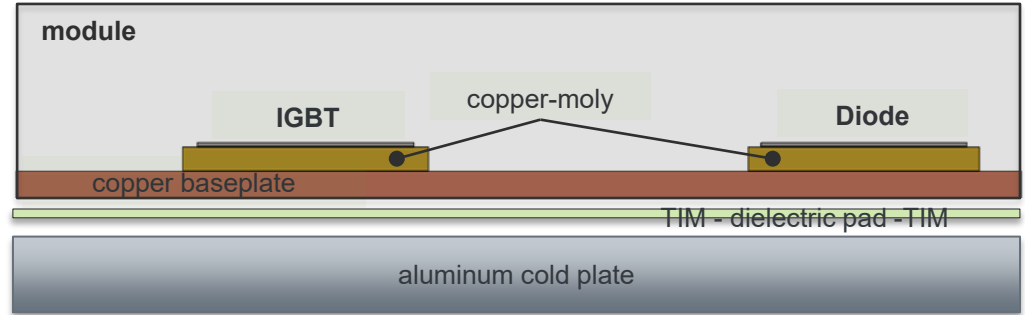
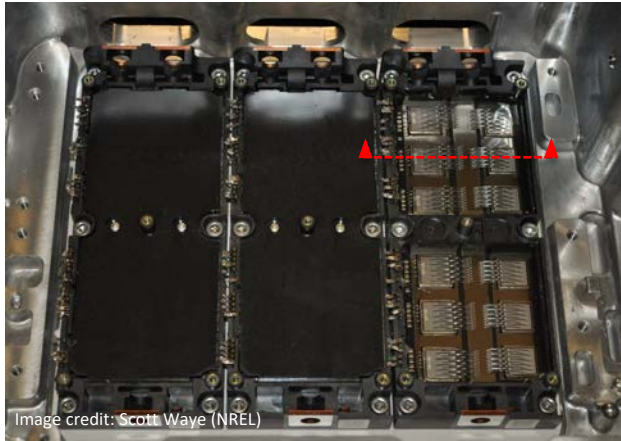
# 2012 LEAF Inverter: 80 kW

**Cold-plate-cooled system**



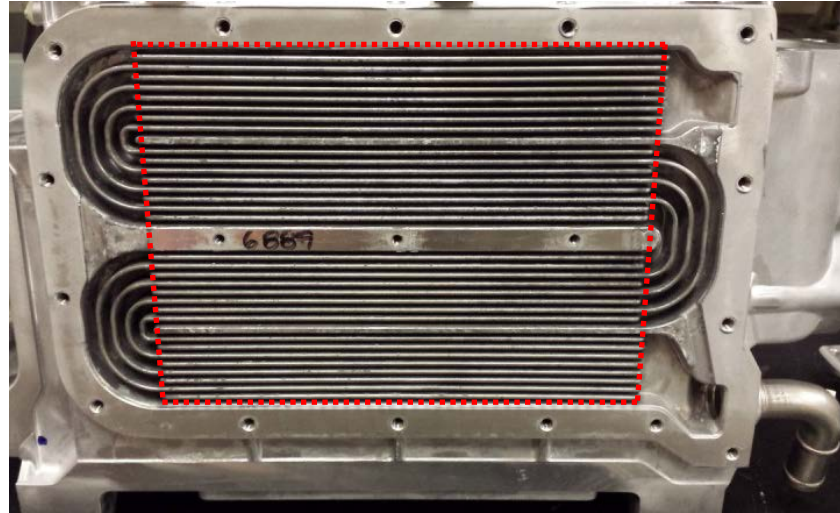
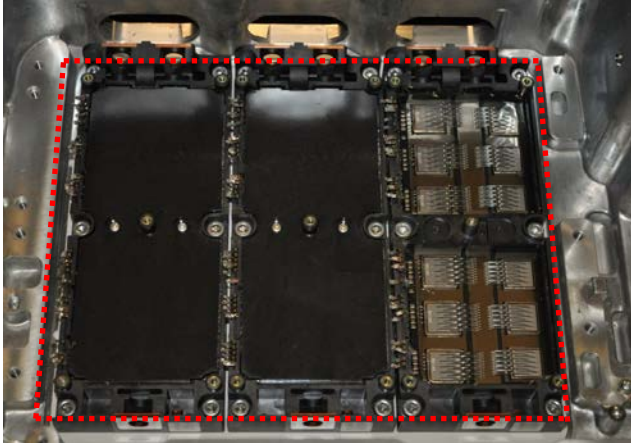
Includes one inverter

# 2012 LEAF Power Module Description



- LEAF modules do not use a metalized-ceramic substrate. Instead, they use a dielectric pad for electrical isolation
- Copper Moly plate beneath the devices for CTE matching
- TIM is provided on both sides of the dielectric pad to reduce the thermal resistance

# 2012 LEAF Heat Exchanger

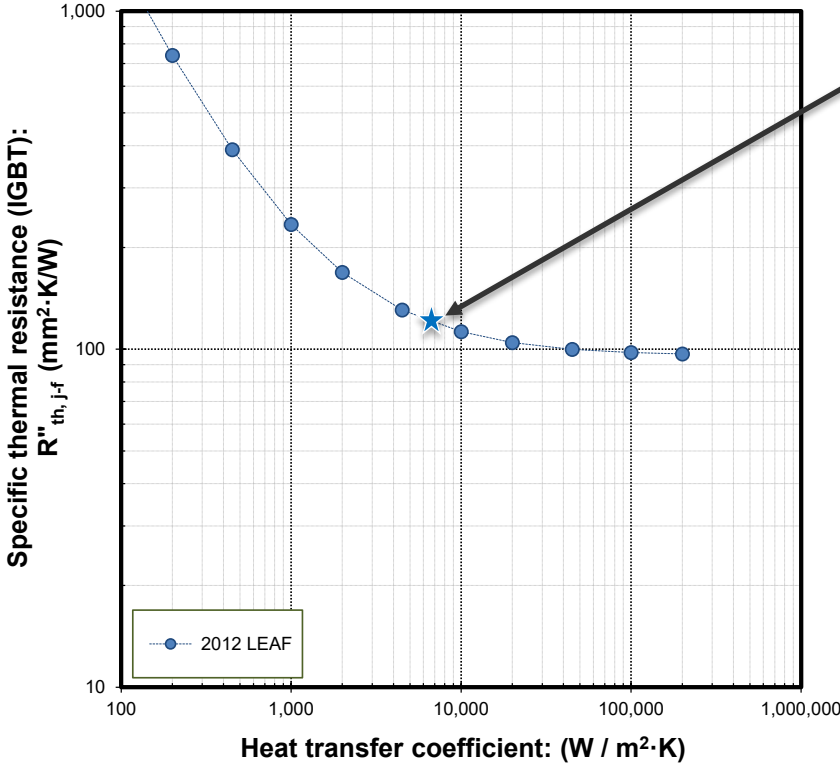


Cast aluminum cold plate

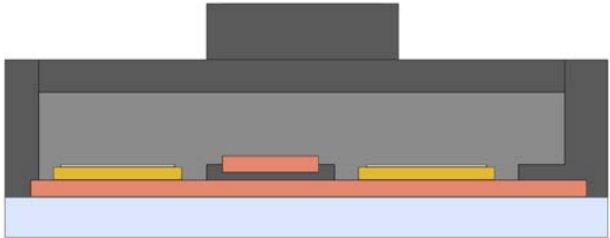


~2-mm-thick fins and channels  
~11.5-mm-tall fins

# 2012 LEAF Thermal Resistance



Estimated cold plate performance at 10 L/min

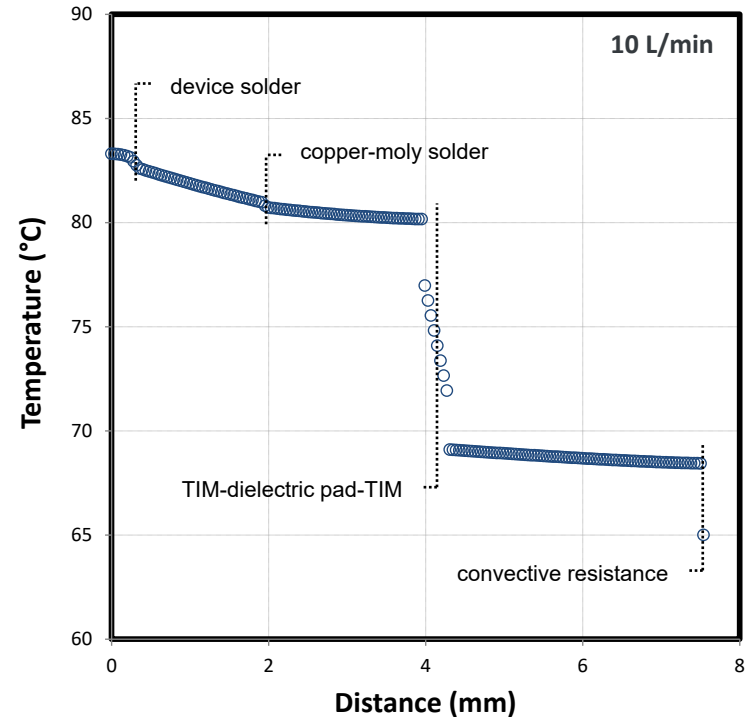


Not much to be gained from increasing convective performance



# 2012 LEAF Junction-to-Coolant Temperature Profile

- Passive stack is about 83% of the total thermal resistance.
- Dielectric pad and associated TIM layers are the largest resistance (~60% of the total temperature drop).
- LEAF design may reduce cost.



# 2014 Honda Accord HEV: 118 kW

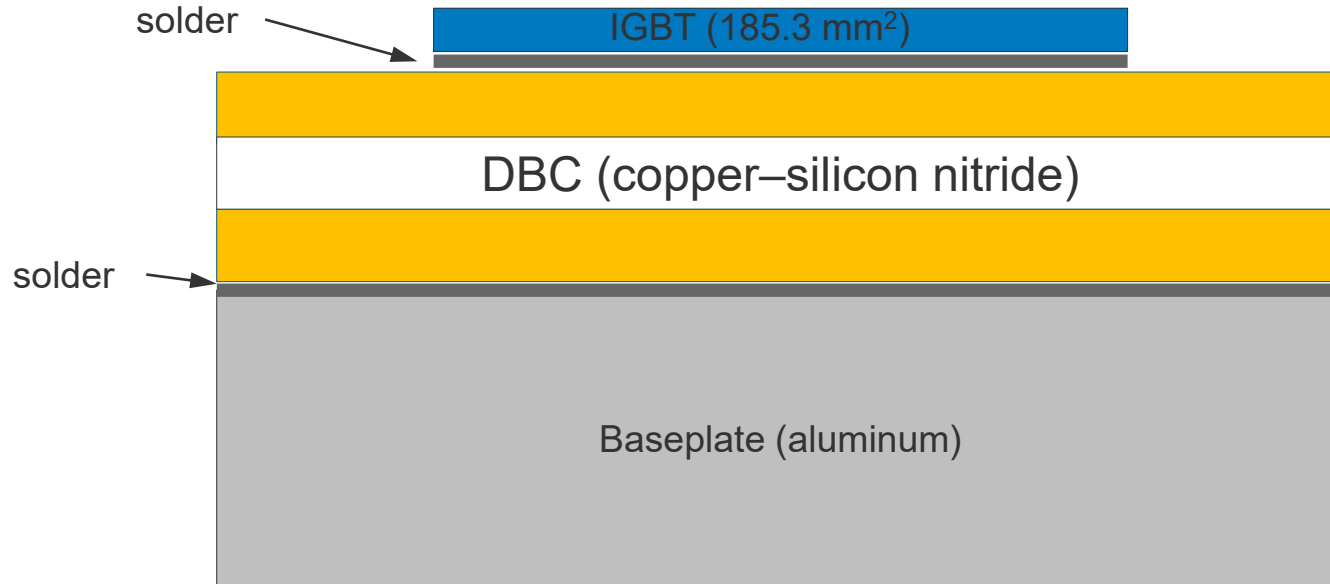
## Baseplate-cooled system



Includes two inverters and one boost converter

# 2014 Accord Module Description

## Power module stack-up

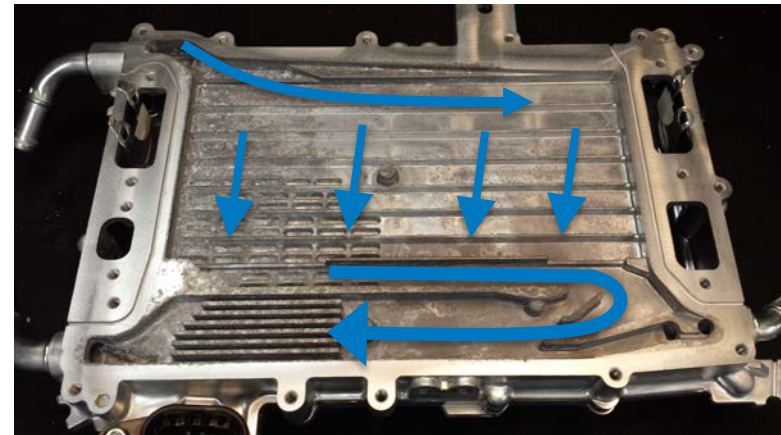
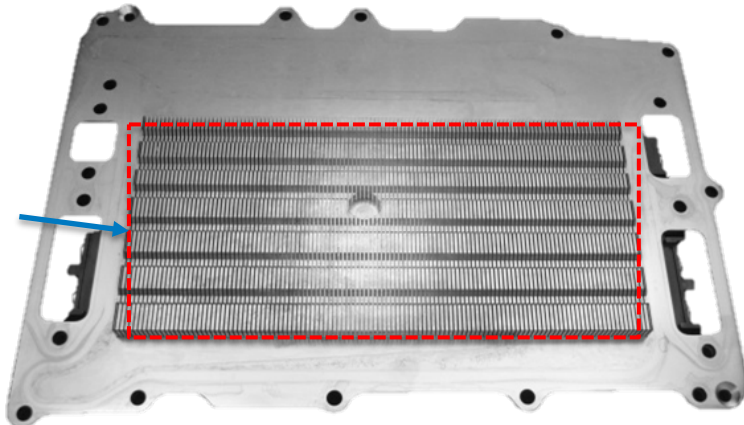


Silicon nitride likely used to improve mechanical performance due to the large CTE discrepancy between aluminum baseplate and Si devices.

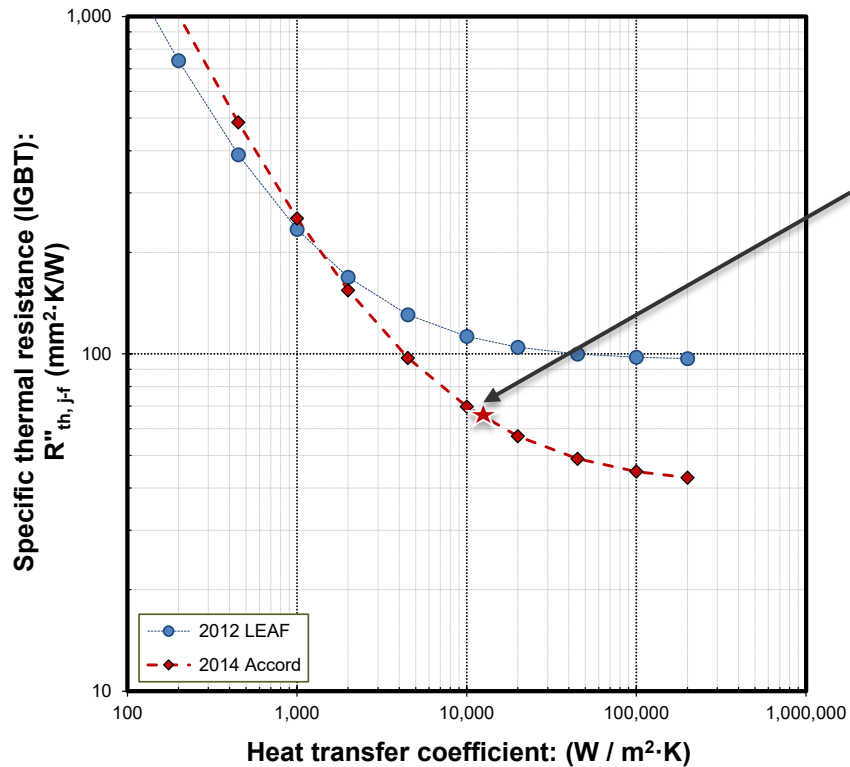
# 2014 Accord Heat Exchanger

Machined aluminum cold plate (baseplate) with nickel plating  
~1-mm-wide channels, 1.2-mm-thick  
and 10-mm-tall fins

Power module  
footprint



# 2014 Accord Thermal Resistance



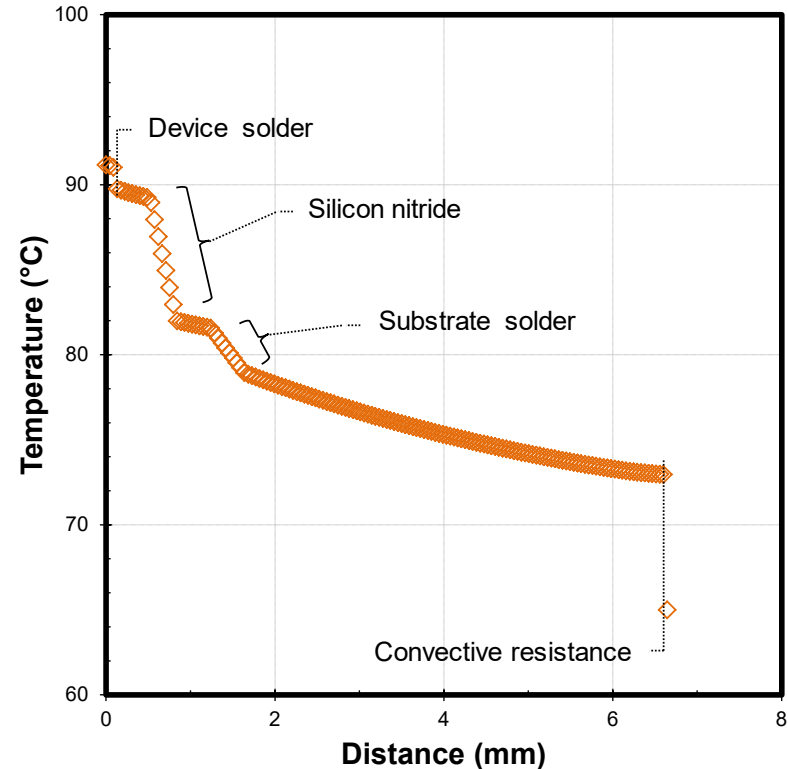
Estimated cold plate performance at 10 L/min

Significant improvement compared to 2012 LEAF thermal performance



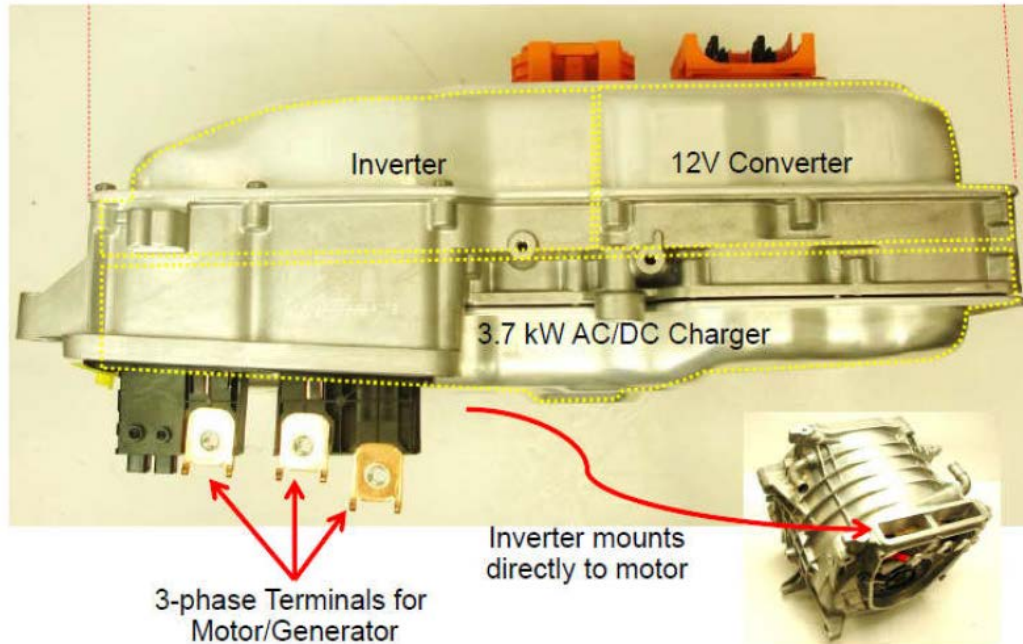
# 2014 Accord Junction-to-Coolant Temperature Profile

- Passive stack is about 70% of the total thermal resistance.
- Ceramic makes up the largest thermal resistance within the package.



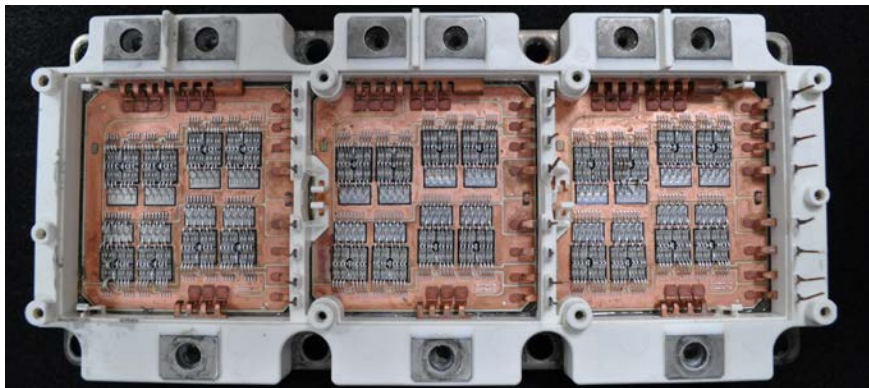
# 2015 BWMi3 EV: 125 kW, 6.8 L

## Baseplate-cooled system



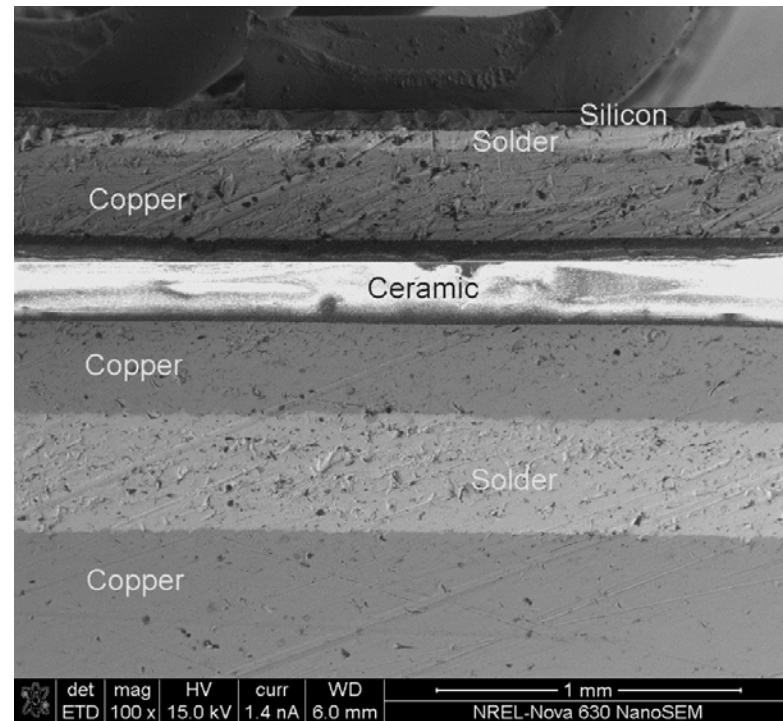
Includes traction inverter, 12-V converter, AC-DC charger

# 2015 BWM i3 Module Description

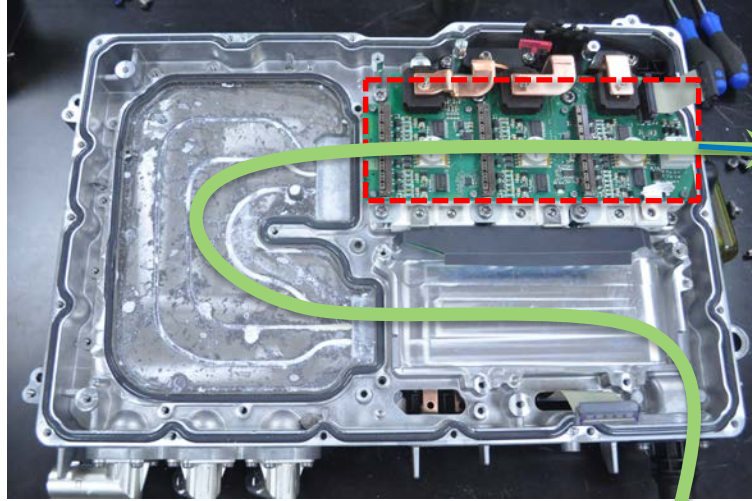


Uses the Infineon HybridPACK2

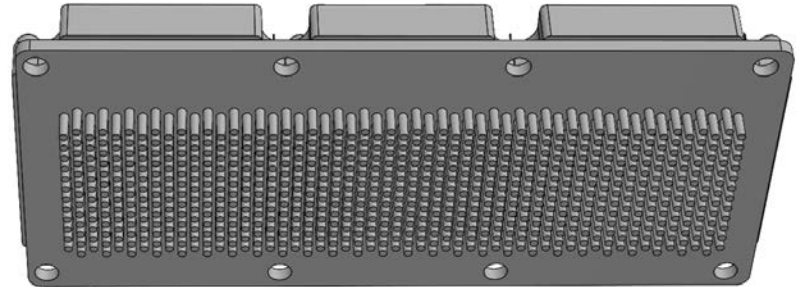
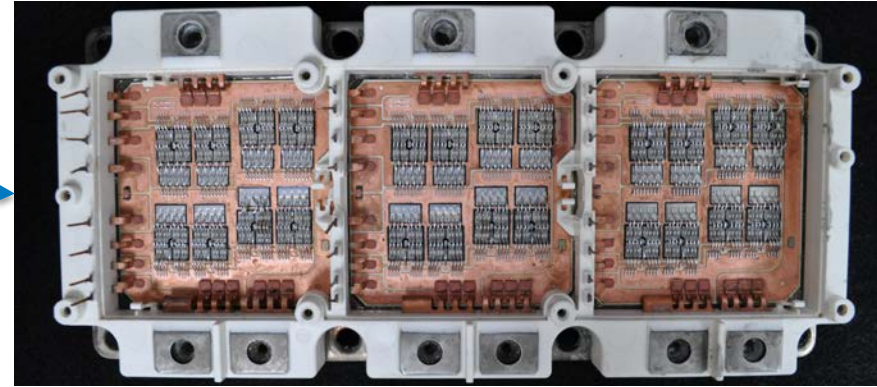
Materials
Silicon (area IGBT = 95 mm <sup>2</sup> , diode = 45 mm <sup>2</sup> )
Die solder
DBC (copper)
DBC (alumina)
DBC solder
Baseplate (copper)



# 2015 BWM i3 Heat Exchanger



Fluid path

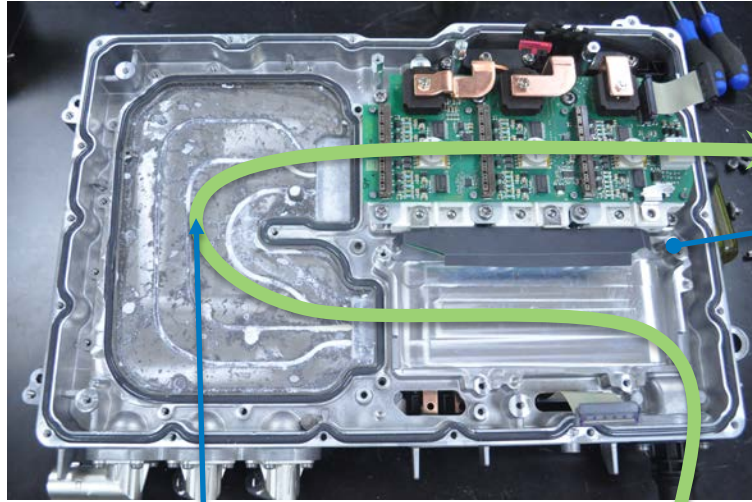


**Pin fins:** diameter = 2.5 mm, height = 8 mm, pitch = 4.2 mm, gap between fins = 1.8 mm





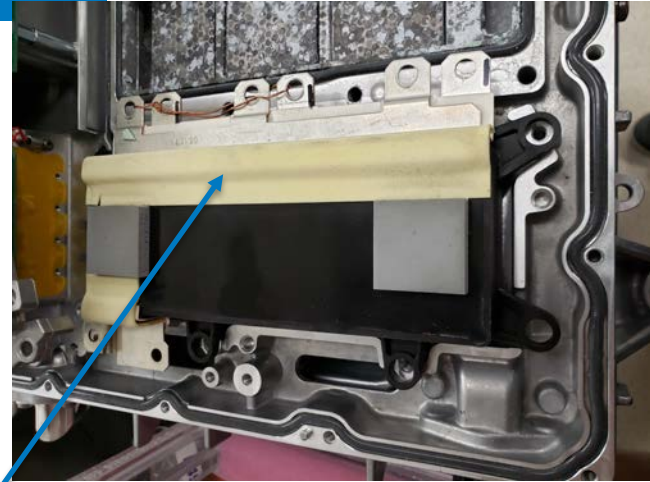
# 2015 BWM i3 Heat Exchanger



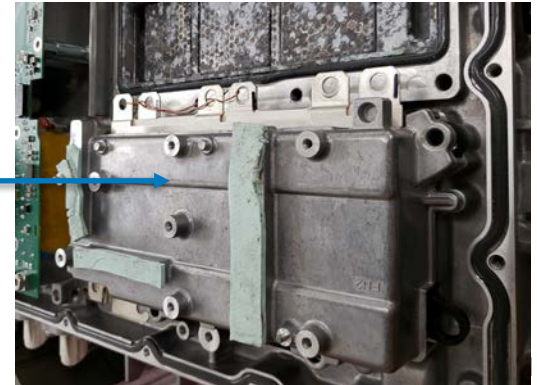
Fluid path

Charger and DC-DC converter cooled via coolant path

Capacitors are mounted to the liquid-cooled aluminum surface. No thermal grease used.

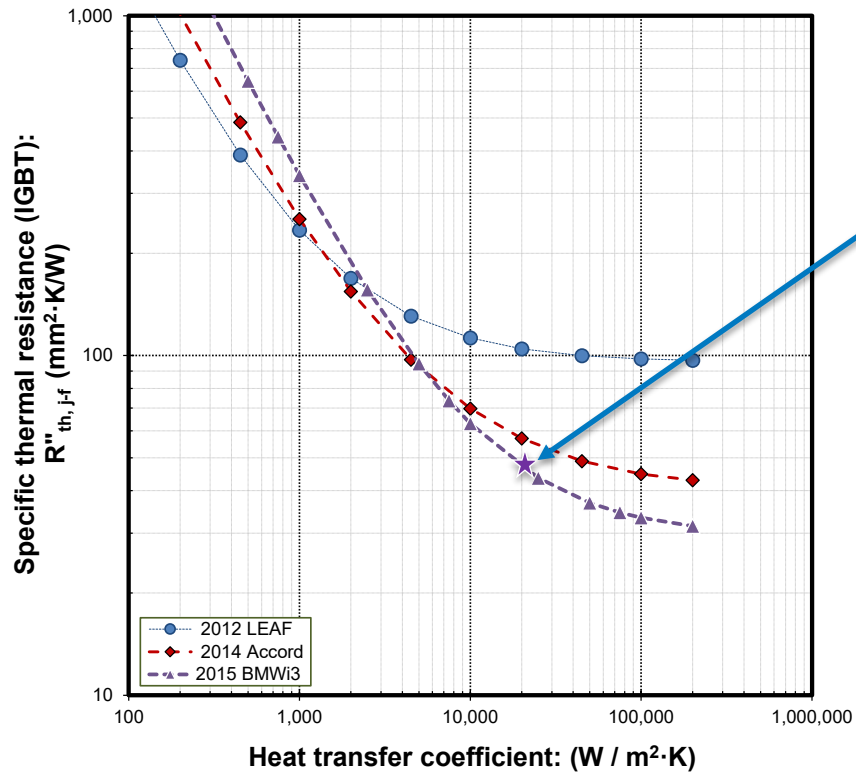


DC bus bars cooled via contact to the aluminum housing and thermal interface pads





# 2015 BMW i3 Thermal Resistance

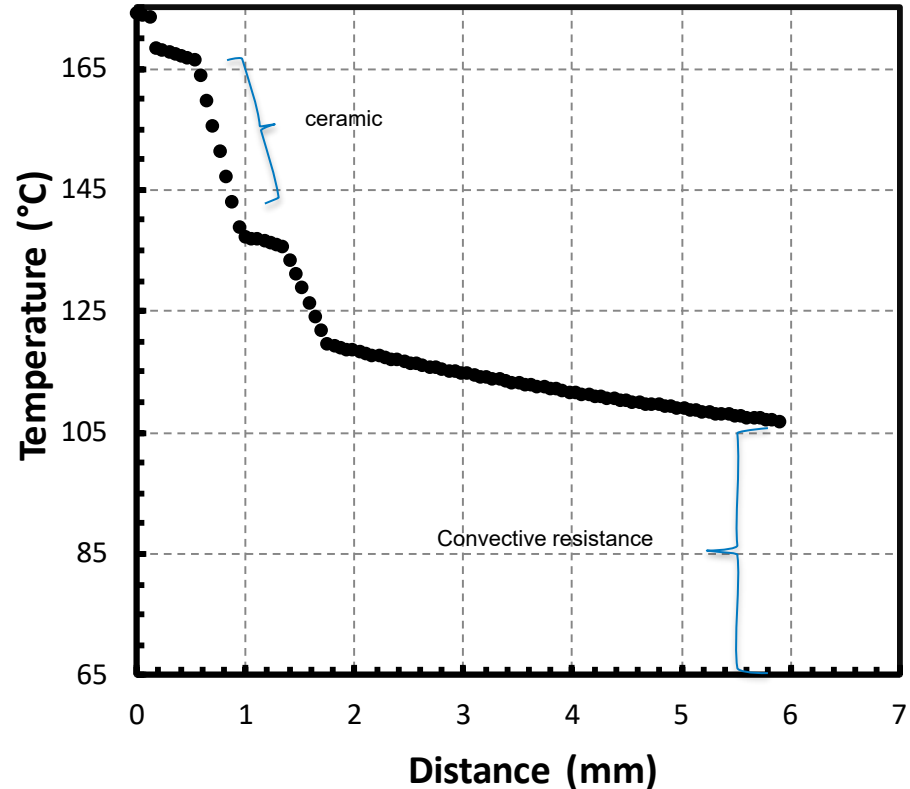


Estimated cold plate performance at 10 L/min

BMW i3 has lower thermal resistance compared to Accord due to higher thermally conductive materials (copper baseplate)

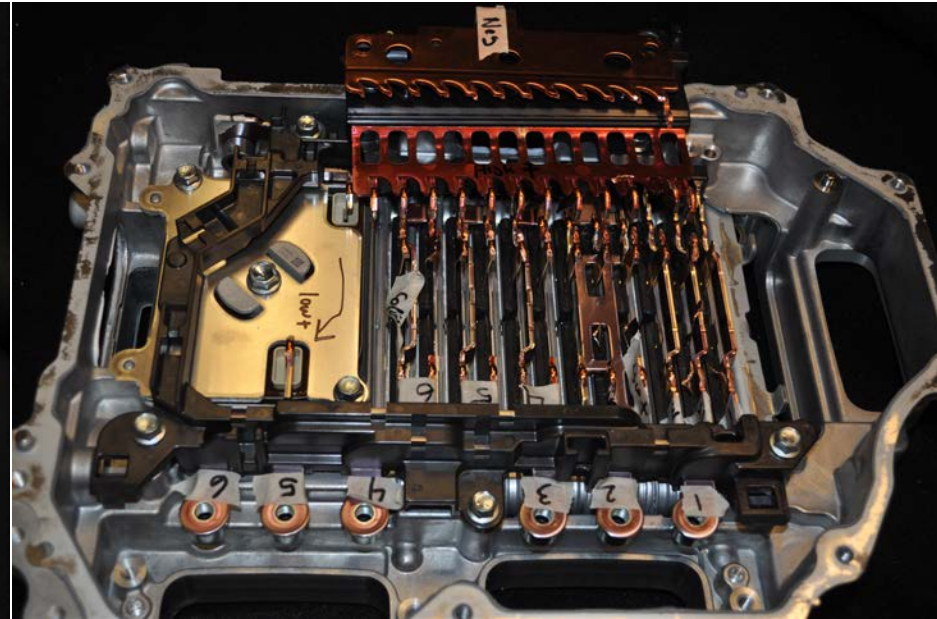
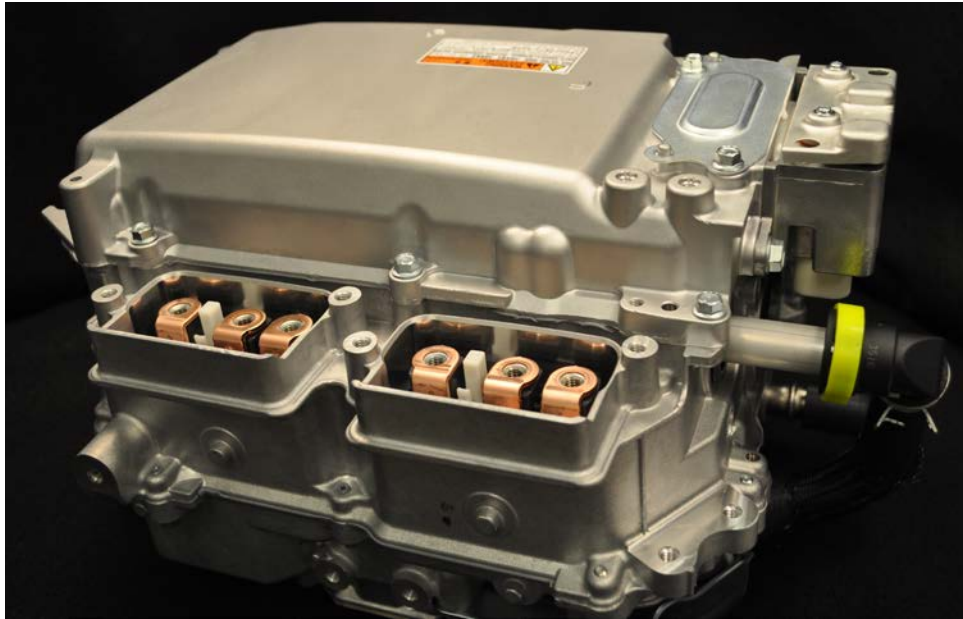
# 2015 BMW i3 Temperature Profile

- Passive stack is about 64% of the total thermal resistance.
- Ceramic makes up the largest thermal resistance within the package.



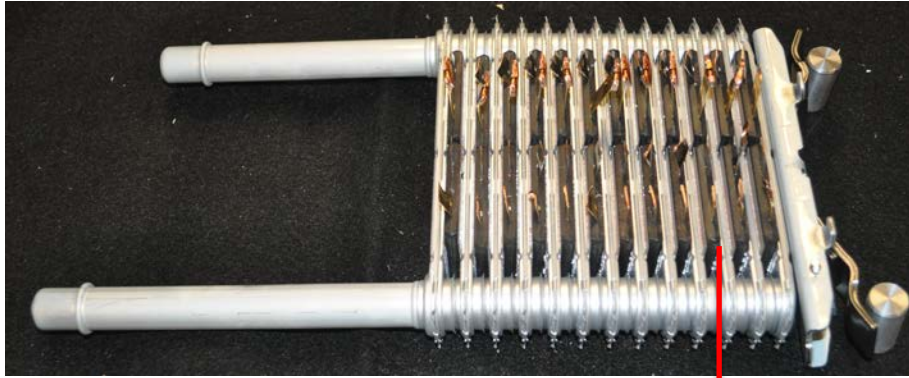
# 2014 Camry HEV: 105 kW

## Double-side-cooled system

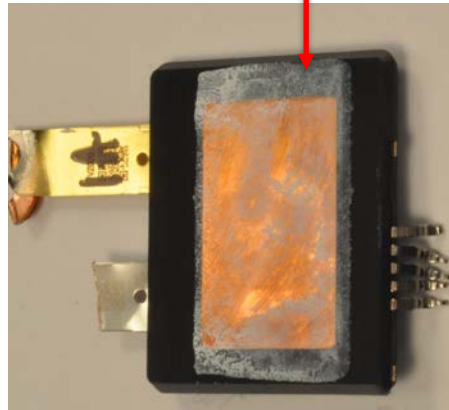


Includes two inverters, DC boost converter, and 12-V converter

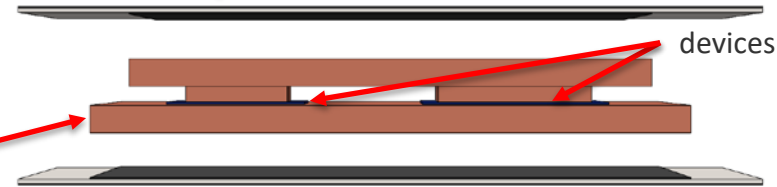
# 2014 Camry HEV



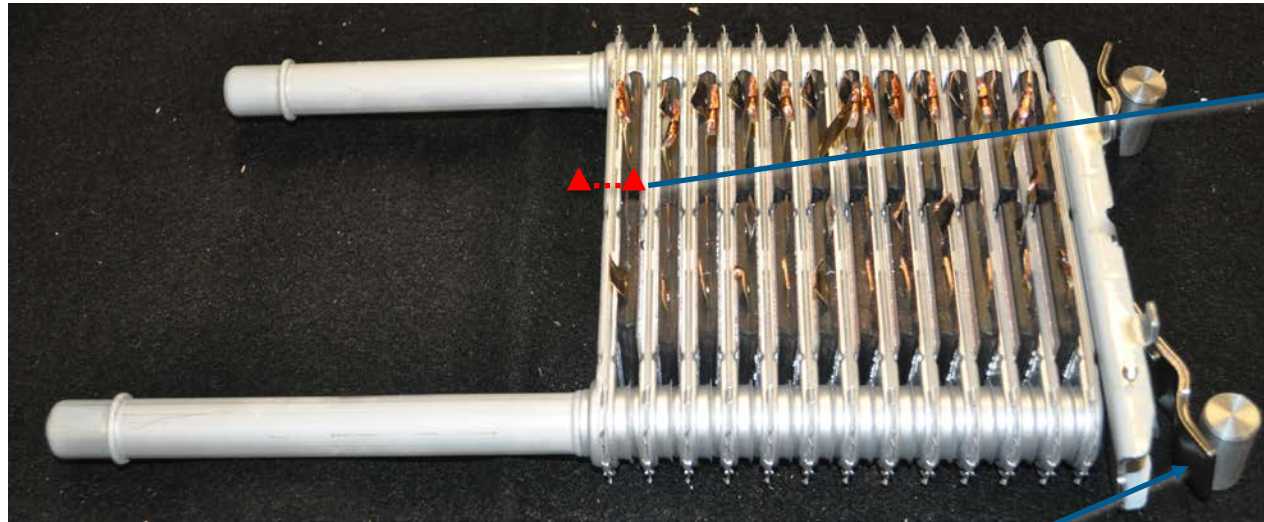
Power module heat exchanger



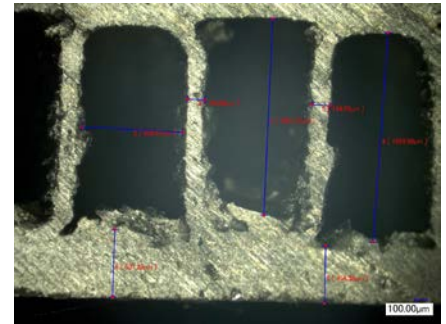
Power module



# 2014 Camry HEV



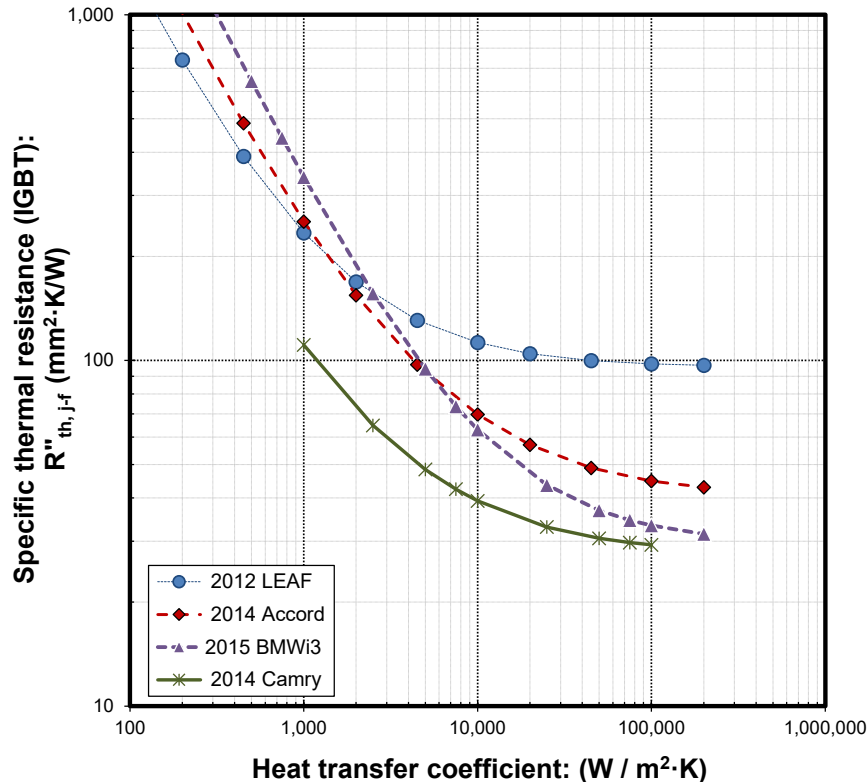
Spring mechanism to minimize thermal contact



Channels: folded fin ~1 x 1.5-mm channels



# 2014 Camry HEV Thermal Resistance



- Lowest thermal resistance values from the double-side-cooled strategy.
- Thermal performance levels off at relatively low heat transfer coefficient (HTC) values—a result of the thermal grease layers.

# Advanced Cooling Technologies Developed at NREL

---

# Jet Impingement: Fundamental Study

- Evaluated both free and submerged water jets on enhanced surfaces.
- Measured HTC of  $30,000 \text{ W/m}^2\cdot\text{K}$  at 2 m/s. Higher HTCs at higher velocities.

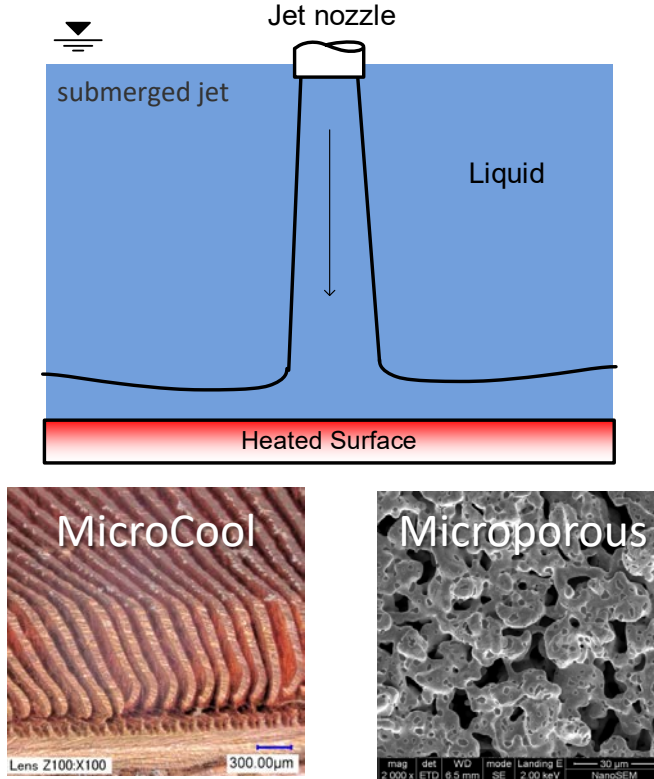
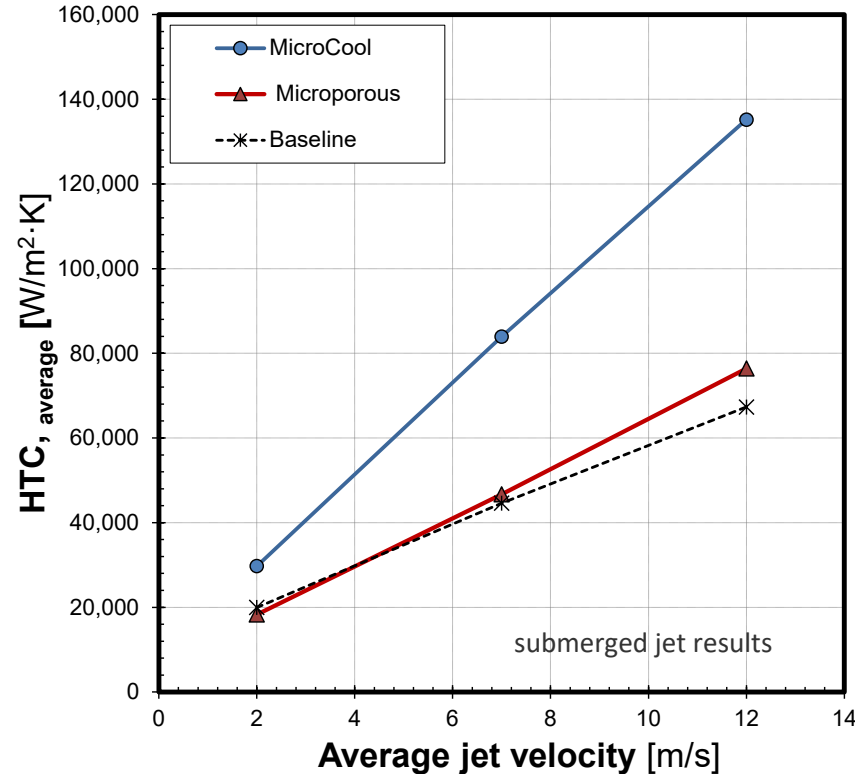


Image credits: Bobby To, NREL



# Jet Impingement: Implementation with WEG

Image credits: Mark Mihalic, NREL

- Used plastic (lightweight and inexpensive) manifold to distribute fluid to the 1.4-mm-diameter jets centered directly behind the devices.
- Used WEG at 10 L/min.
- Reduced thermal resistance by 17% with jets on MicroCool surface compared to baseline case with equivalent pumping power.

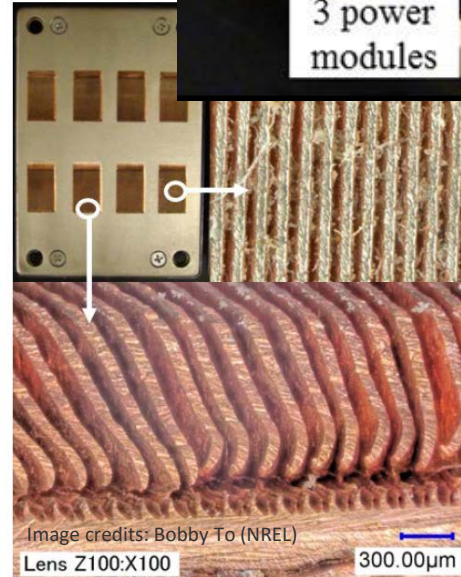
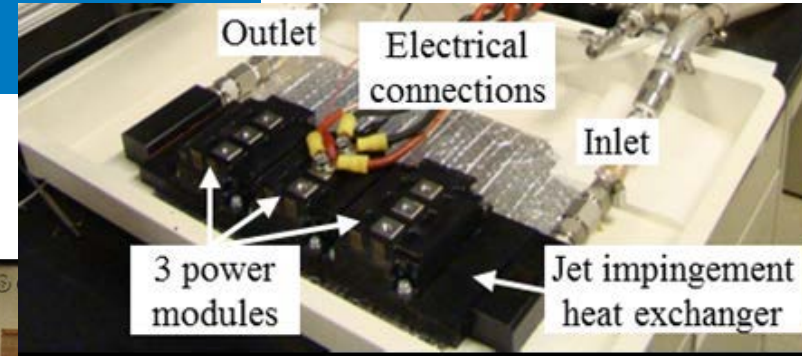


Fig. 3 Wolverine Tube MicroCool finned surface technology on module (top left) and close-up (top right and bottom).

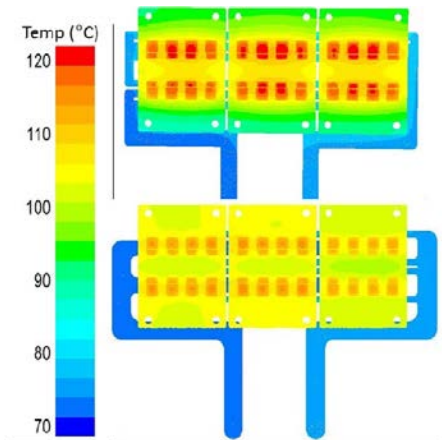
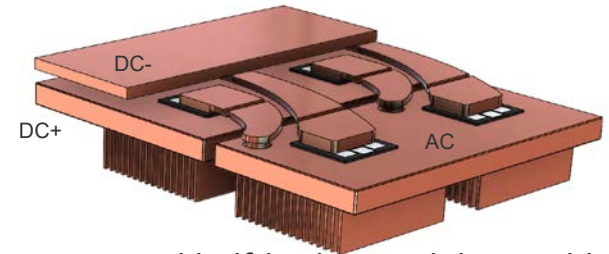
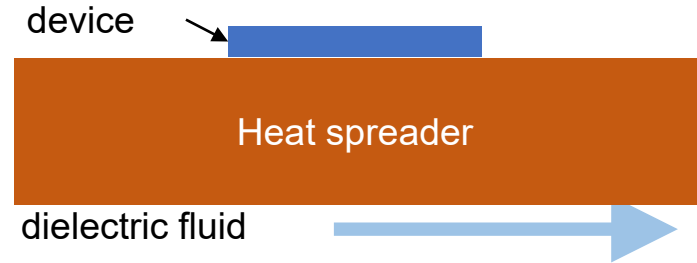
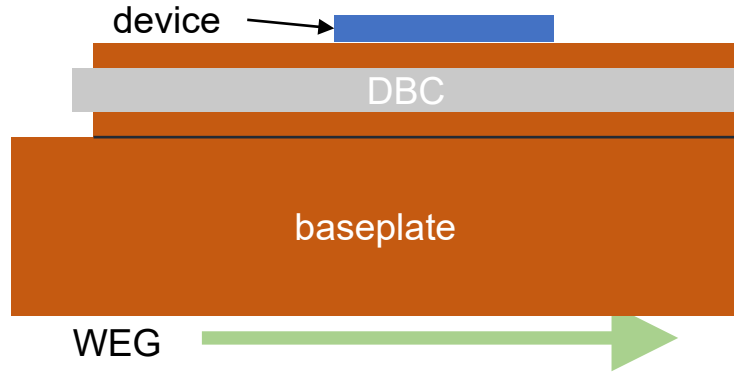


Fig. 9 Temperatures of modules for baseline (top) and jet impingement on the plain surface for the first prototype (bottom). The second prototype has similar thermal performance.

# Jet Impingement: Implementation with Dielectric Fluids (Single-Phase)



*Conceptual half-bridge module suitable for dielectric fluid cooling*

Dielectric fluids can eliminate layers in the package to reduce thermal resistance, allow for direct cooling of the bus bars, and allow for the potential to use driveline fluids as coolants.



# Jet Impingement: Implementation with Dielectric Fluids (Single-Phase)

- Selected synthetic hydrocarbons that are used in electronics cooling (single-phase) applications:
  - Alpha 6: DSI Ventures
  - AmpCool (AC)-100: Engineered Fluids
- Potential to use automatic transmission fluid (ATF) to decrease cost, use fluid already qualified for automotive use, enable motor–inverter integration.
- Challenge is to create a cooling system with high thermal performance using fluids with relatively inferior heat transfer properties as compared to WEG.

Fluid <i>(properties at 70°C)</i>	Thermal conductivity [W/m-K]	Specific heat [J/kg-K]	Density [kg/m <sup>3</sup> ]	Viscosity [Pa-s]	Flash point [°C]	Pour point [°C]	Breakdown voltage (ASTM D1816) [kV]	Dielectric constant (ASTM D924)
Alpha 6 <sup>1</sup>	0.14	2,308	792	0.0091	246	-57	58	?
AC-100 <sup>1</sup>	0.13	2,326	761	0.0025	180	-55	>60	2.3
ATF <sup>2</sup>	0.16	2,131	836	0.012	199	-45	?	?
WEG (50/50) <sup>3</sup>	0.42	3,513	1,034	0.0013	> 121 <sup>4</sup>	-36 (freeze point) <sup>5</sup>	-	-

<sup>1</sup> Communications with vendor (DSI Ventures or Engineered Fluids)

<sup>2</sup> S. P. Kemp and James L. Linden. 1990. "Physical and Chemical Properties of a Typical Automatic Transmission Fluid." SAE Technical paper.

<sup>3</sup> K. Alshamani. 2003. "Equations for Physical Properties of Automotive Coolants." SAE Technical Paper.

<sup>4</sup> "Safety Data Sheet ZEREX HD Nitrile Free Extended Life 50/50 Antifreeze Coolant." Valvoline. Accessed April 1, 2019. <https://sds.valvoline.com/valvoline-sds/sds/materialDocumentResults.faces>.

<sup>5</sup> "Product Information: Valvoline ZEREX G05 Antifreeze Coolant." 2018. <https://sharena21.springcm.com/Public/Document/18452/f93a8057-fe75-e711-9c10-ac162d889bd3/c264d227-0dbd-e711-9c12-ac162d889bd1>.

# Jet Impingement: Implementation with Dielectric Fluids (Single-Phase)

## Single-side cooled

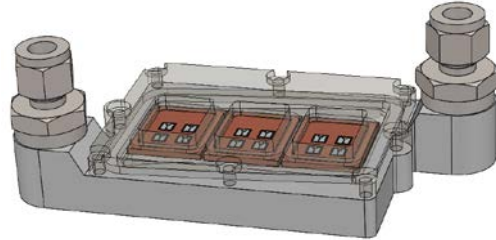
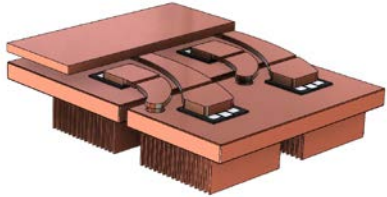
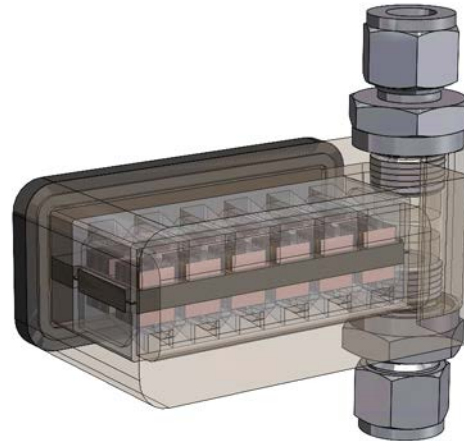
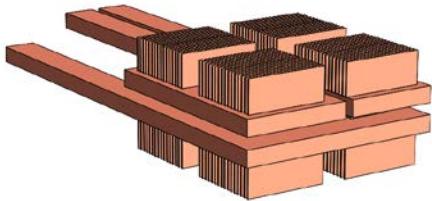
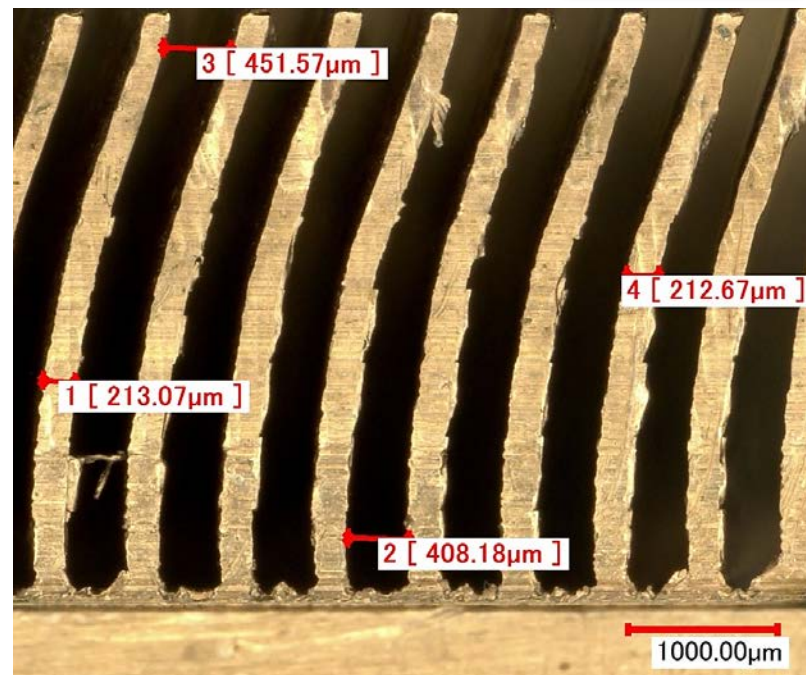
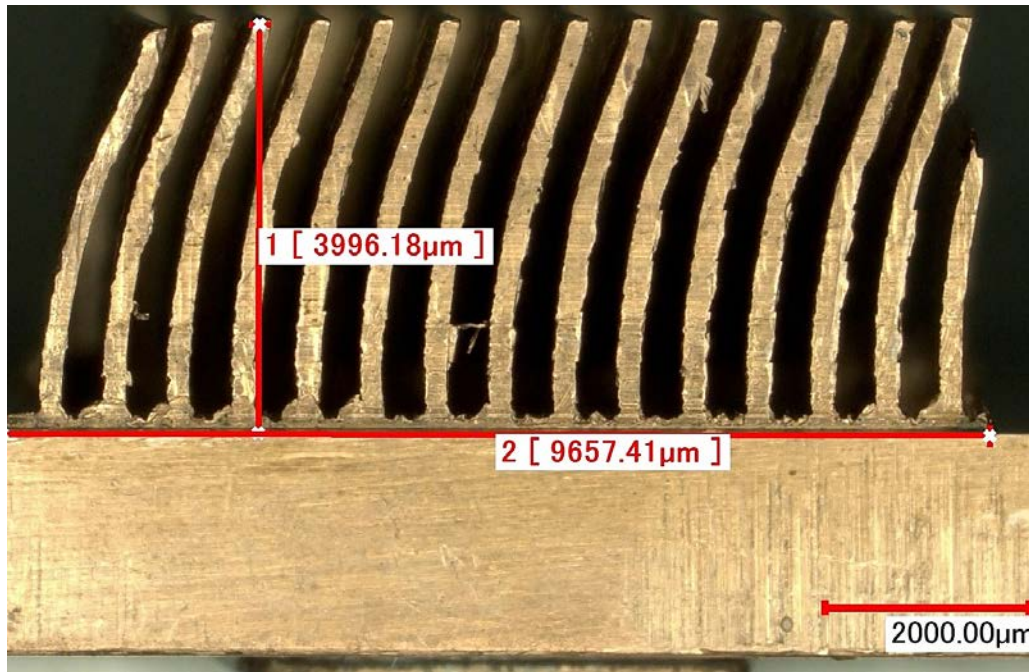
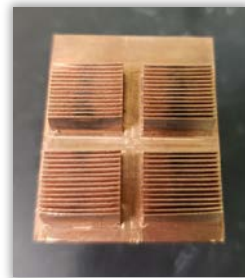


Image credit: Gilbert Moreno, NREL

## Double-side cooled



# Jet Impingement: Implementation with Dielectric Fluids (Single-Phase)



# Jet Impingement: Implementation with Dielectric Fluids (Single-Phase)

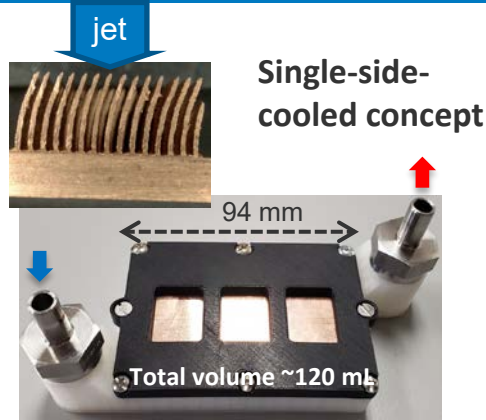
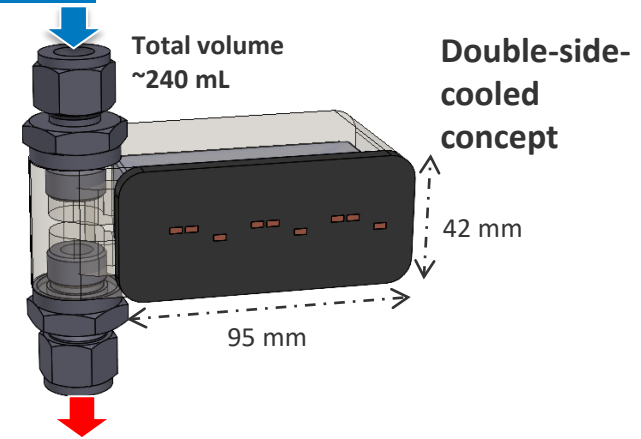


Image credit: Gilbert Moreno (NREL)



\* Estimates assuming  $T_{\text{fluid}} = 70^{\circ}\text{C}$

System	Thermal resistance (junction-to-fluid) $\text{mm}^2 \cdot \text{K}/\text{W}$	Flow rate $\text{L}/\text{min}$	Pressure drop $\text{psi} [\text{kPa}]$	$T_j$ maximum $^{\circ}\text{C}$	Device heat flux* $\text{W}/\text{cm}^2$	Total volume (power modules and cold plate) $\text{mL}$
2015 BMW i3, (WEG cooled)	49	10	1.4 [9.6]	175	214	900
Single-side-cooled dielectric fluid	20	4.1	0.2 [1.4]	175	525	120
Double-side-cooled dielectric fluid	11	4.1	0.6 [4.1]	175	875	240

# Two-Phase Cooling

- Measured boiling heat transfer performance on 10×10 mm heated surfaces Evaluated the following:
  - Refrigerants: R-245fa, R-134a, HFO-1234yf, HFE-7100
  - Enhanced surface: Microporous Coating, nanostructures
- Achieved HTC's ~50,000 W/m<sup>2</sup>-K on smooth (and no fins) surfaces
- Measured HTC's > 200,000 W/m<sup>2</sup>-K within small heat flux range
- CHF is a one of the major limitations of boiling heat transfer. Requires enhanced surfaces to increase CHF and/or limit the heat flux on the boiling surfaces

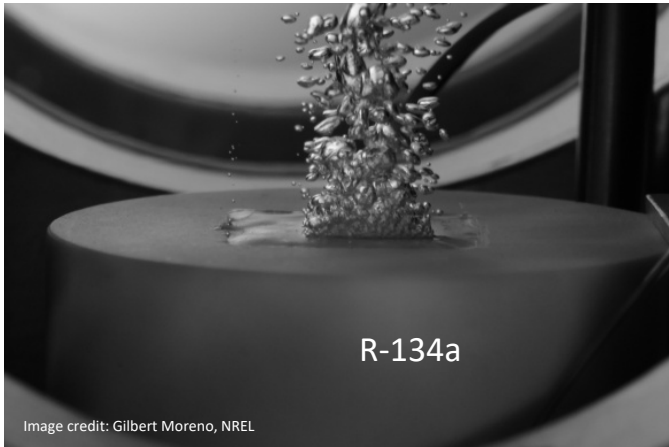
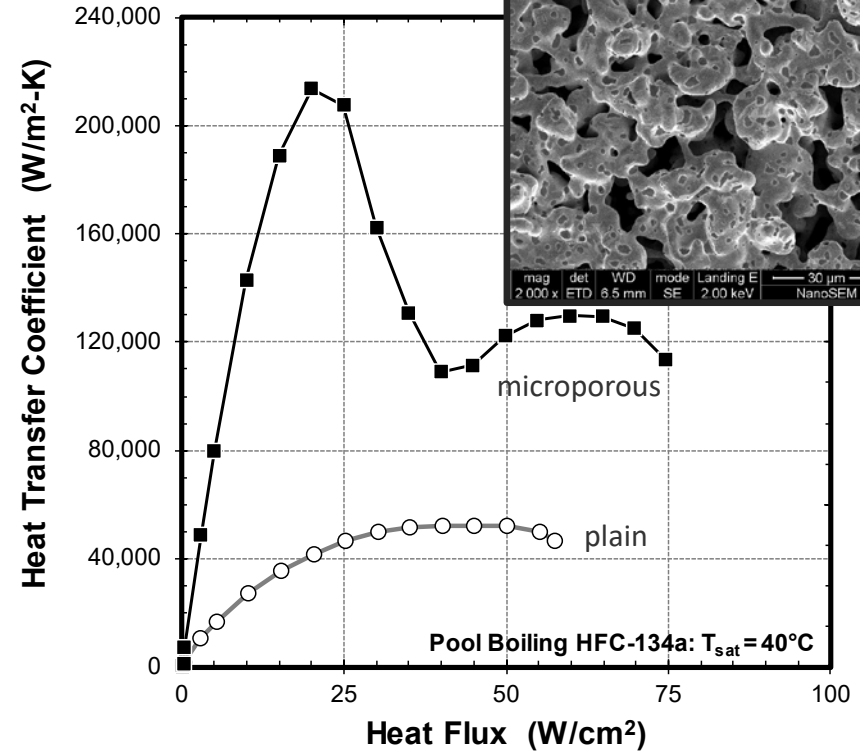


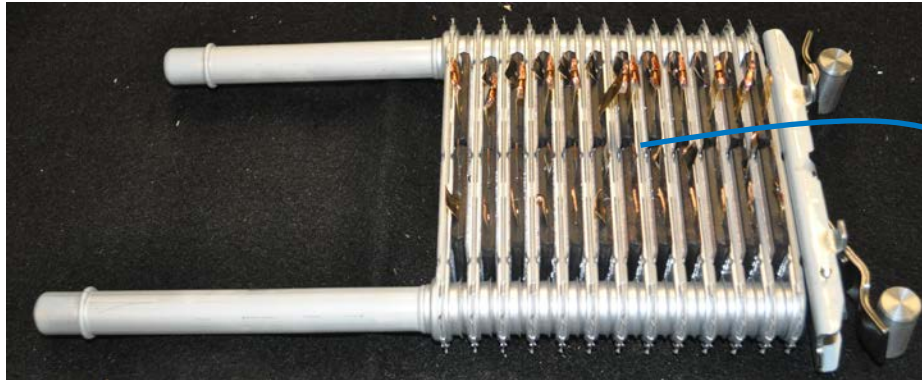
Image credit: Gilbert Moreno, NREL





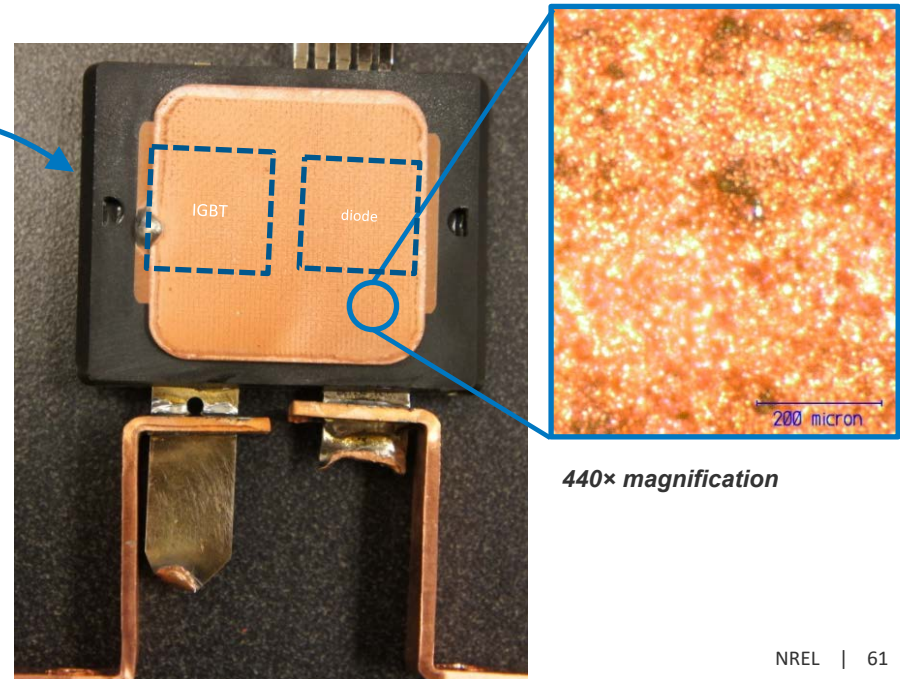
# Passive Two-Phase: Module-Scale Demonstration

Demonstrated two-phase cooling (immersion cooling) on an automotive power module (2008 Lexus Hybrid)



**Manufacturer's cooling system: double-side cooling**

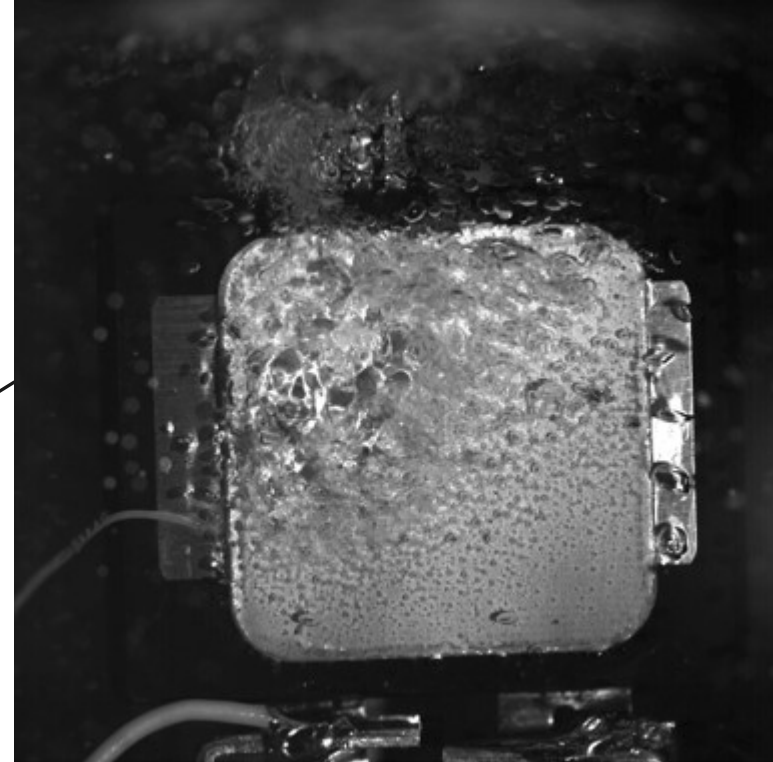
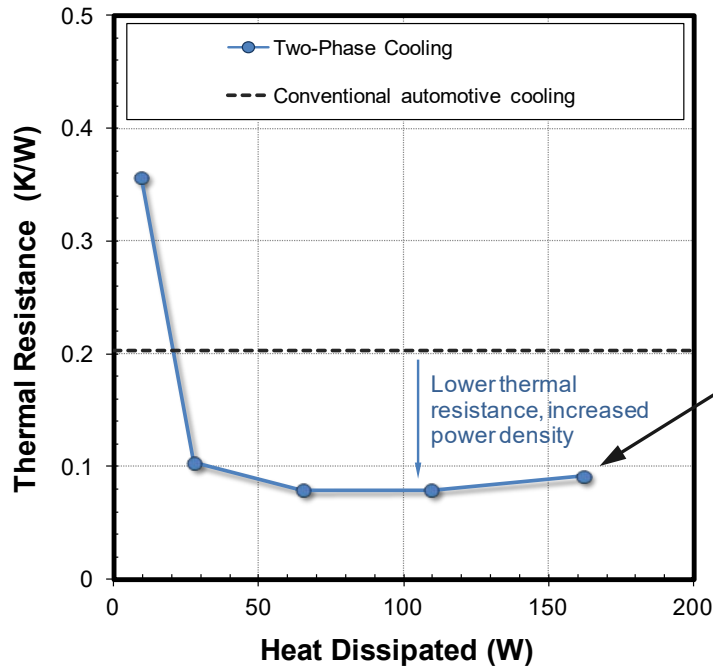
**Power module coated with 3M microporous coating**



**440x magnification**

# Passive Two-Phase: Module-Scale Demonstration

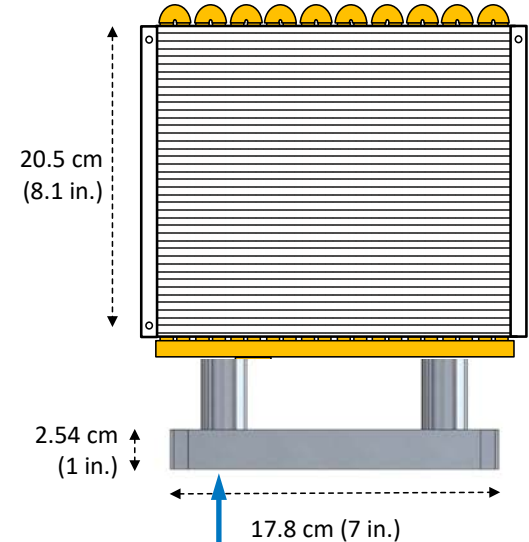
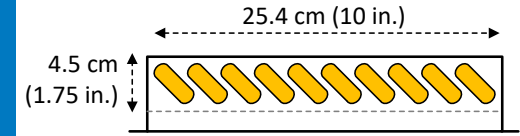
Two-phase cooling with microporous coating reduced thermal resistance by over 60% as compared with the 2008 Lexus system—better performance with no pump required.



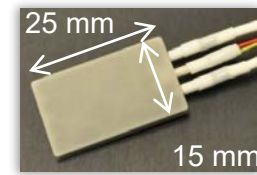
Immersion cooling: HFE-7100 refrigerant

# Passive Two-Phase: Inverter-Scale Demonstration

- Cools six Delphi power modules
- Used ceramic heaters as a substitute for the Delphi modules
- Finned-tube condenser with a 38-W axial fan (7-in diameter)
- Two evaporator concepts were tested.

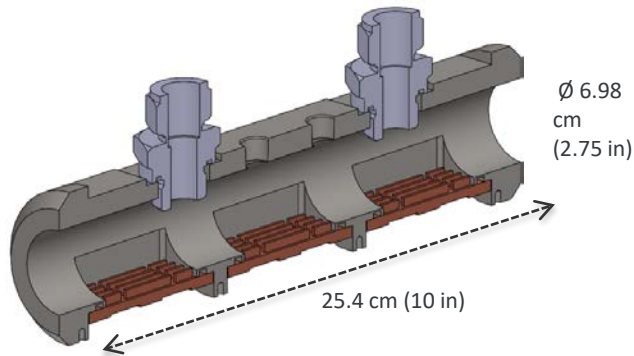


*Delphi discrete power module:* Image credit: Gary Eesley (Delphi)



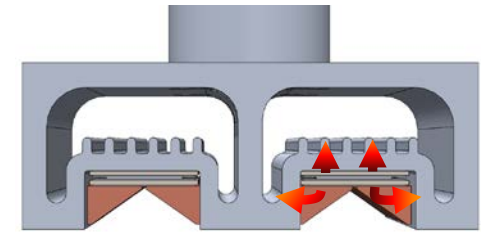
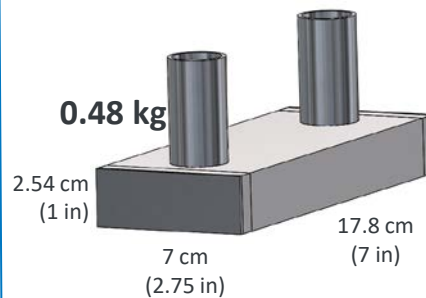
# Passive Two-Phase: Inverter-Scale Demonstration

## Copper cold plate design



- Interchangeable cold plate design
- Charged with 250 mL of refrigerant

## Advanced all-aluminum design

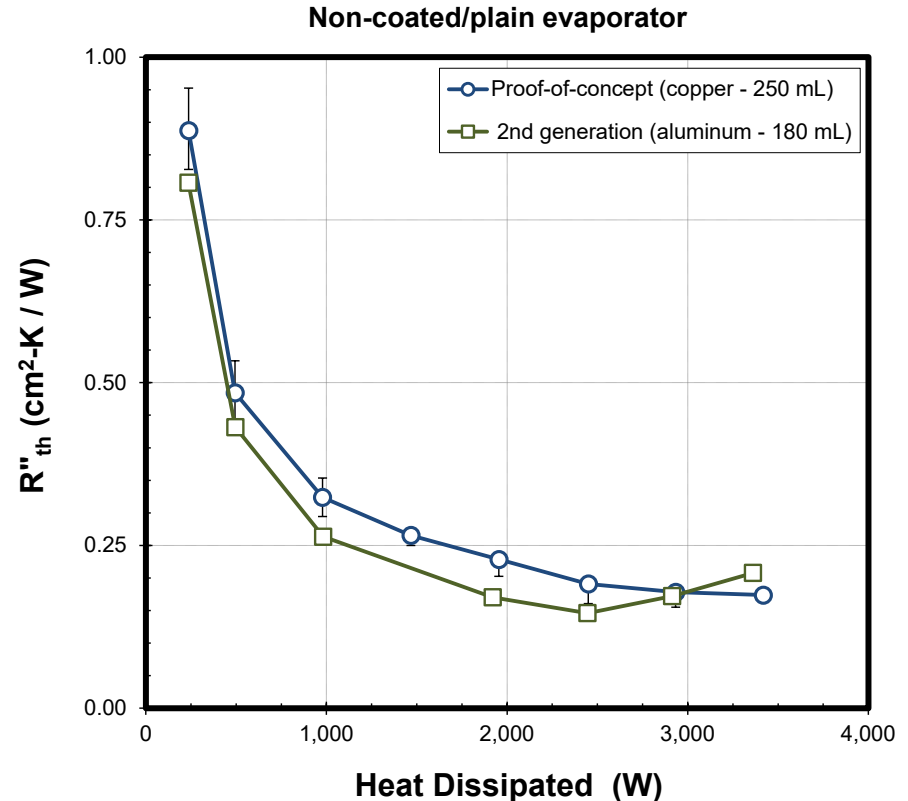
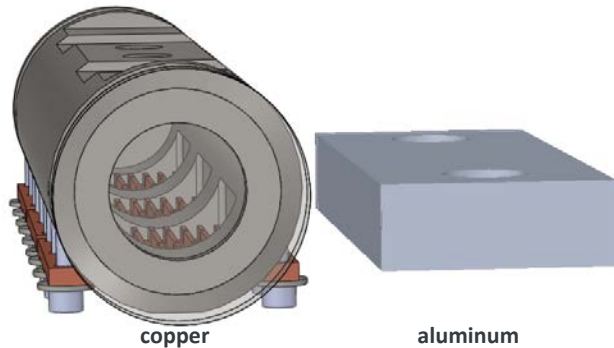


Heat conduction path from backside of the electronic device to the evaporator surface

- Fabricated from low-cost materials (aluminum) using low-cost manufacturing techniques
- Reduced refrigerant requirements to 180 mL, (HFO-1234yf = 200 g, R-245fa = 240 g)
  - Comparison: 2010 Toyota Camry air-conditioning system uses 510 g of R-134a.

# Passive Two-Phase: Inverter-Scale Demonstration

- Dissipated 3.5 kW of heat with only 180 mL of R-245fa





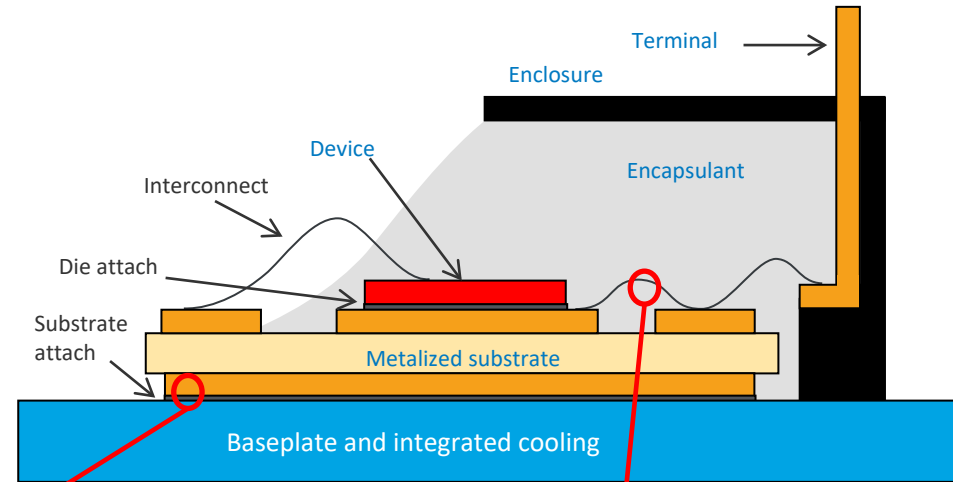


# Power Electronics Materials and Component Reliability

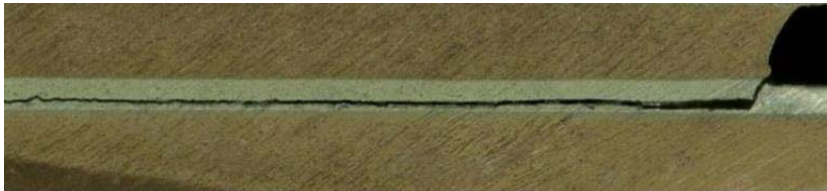
Sreekant Narumanchi

# Advanced Power Electronics Packaging Performance and Reliability

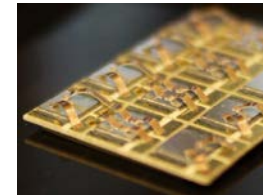
- Improve reliability of new (high-temperature/WBG) technologies
- Develop predictive and remaining lifetime models
- Package parametric modeling.



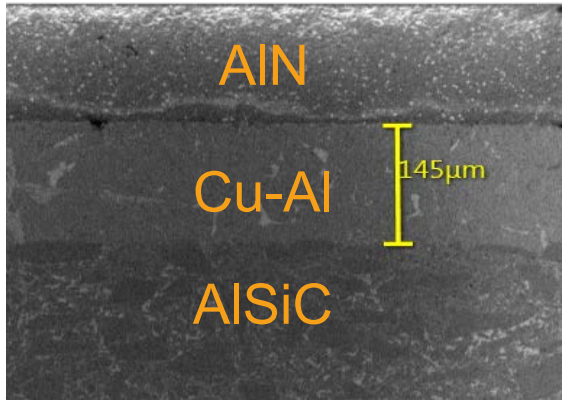
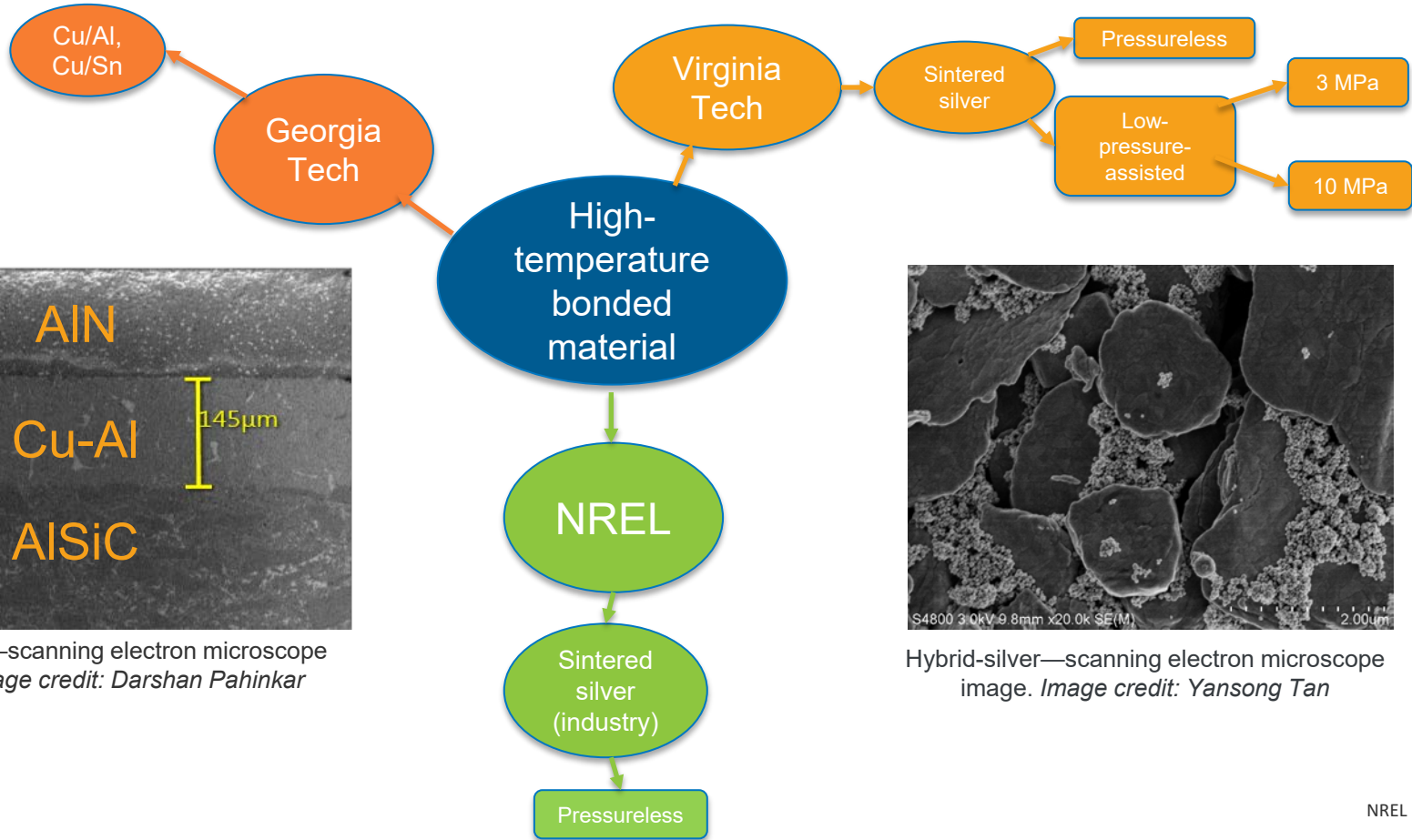
Bonded interface



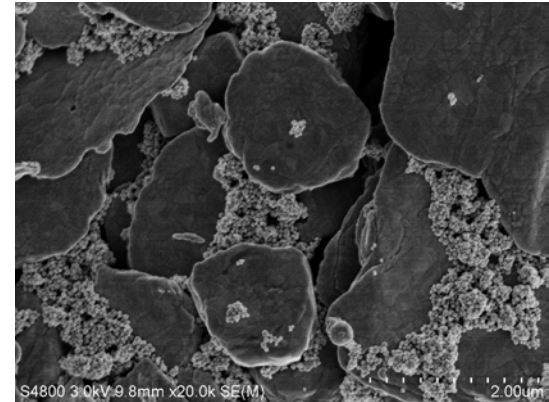
Electrical interconnects



# Approach – Materials, Bonded Interfaces



Cu-Al bond—scanning electron microscope image. *Image credit: Darshan Pahinkar*



Hybrid-silver—scanning electron microscope image. *Image credit: Yansong Tan*

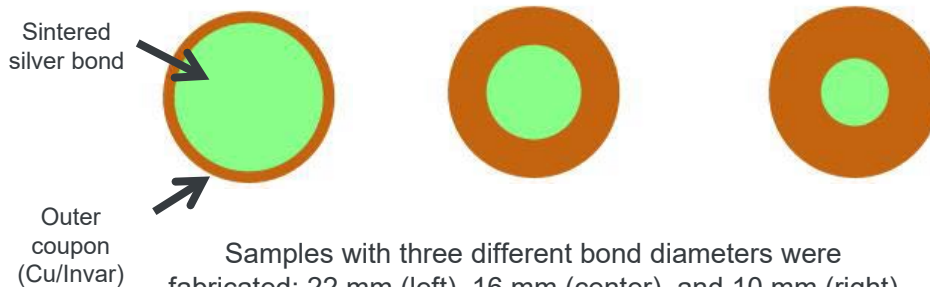
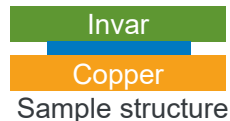


# Approach – Reliability Evaluation



Image credit: Douglas DeVoto

1-inch-diameter copper and Invar coupons:  
non-plated (top), plated with 4- $\mu$ m-thick  
silver (bottom)



Samples with three different bond diameters were fabricated: 22 mm (left), 16 mm (center), and 10 mm (right)

*Accelerated thermal cycling*

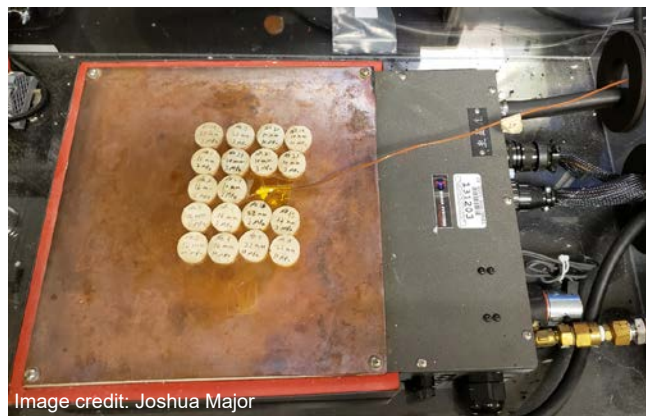
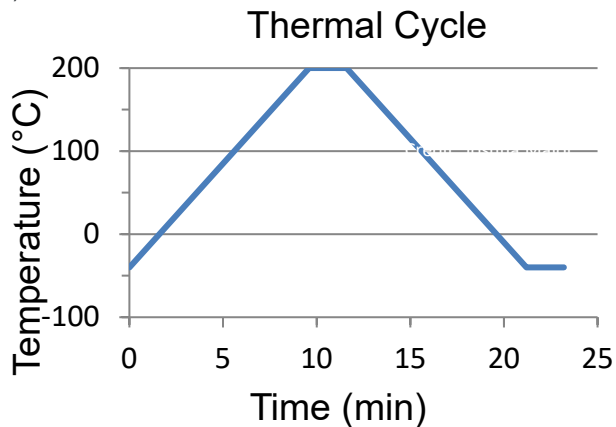


Image credit: Joshua Major

Samples placed on thermal platform for thermal cycling; C-mode scanning acoustic microscope images of these samples are taken periodically.

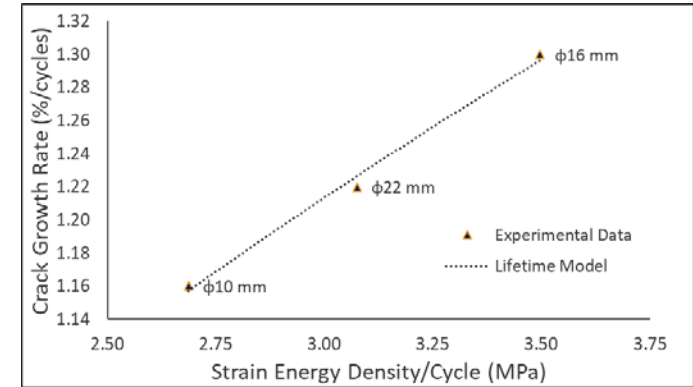
# Lifetime Model of Sintered Silver Will Guide Advanced Power Electronics Module Design

- Sintered silver exhibited predominantly adhesive fracture under thermal cycling experiments.
- We correlated the crack growth rate measurements with the strain energy density per cycle modeling results to formulate the lifetime prediction model.
- The lifetime prediction model (equation given below) is the first in the literature that incorporates the thermomechanical degradation of sintered silver at 200°C.

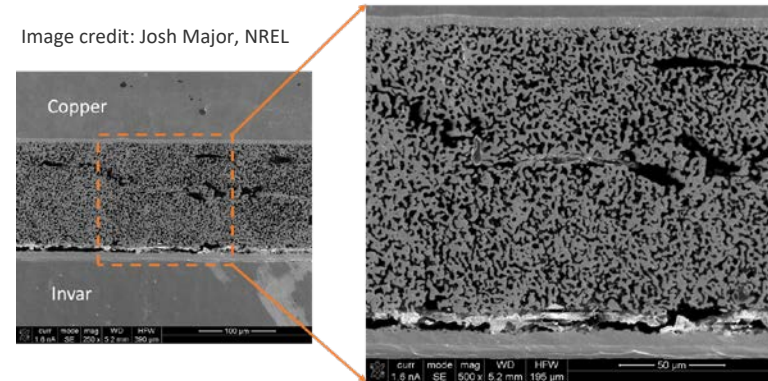
$$\frac{dA}{dN} = 0.76 \Delta W^{0.431}$$

$\frac{dA}{dN}$  = crack growth rate,  $\Delta W$  = strain energy density/cycle

- Power electronics packaging design engineers can use the lifetime model to estimate and improve the reliability of their high-temperature packages with sintered silver as the bonded interface.



Lifetime prediction model



Failure mechanisms in sintered silver



# Substrate Alternatives Research

- DBC
  - Oxidation of Cu foils during bonding lowers melt temperature from 1,083°C to 1,065°C
  - Maximum metallization thickness of 1 mm
  - Must have metallization layers on both sides of ceramic
- Active metal bonding
  - Brazing process with Ag-Cu alloy between Cu and ceramic at 850°C in vacuum
  - Requires more process steps and is more expensive than DBC
- Organic direct-bond copper (ODBC)
  - A polyimide dielectric is bonded with metal
  - No limitations in metal material or metallization thickness.

# ODBC Reliability

- Thermal shock:  $-40^{\circ}\text{C}$  to  $200^{\circ}\text{C}$ , 5-minute dwells
- Thermal aging:  $175^{\circ}\text{C}$
- Power cycling:  $40^{\circ}\text{C}$  to  $200^{\circ}\text{C}$
- ODBC substrates reached 5,000 thermal shock cycles, 1,900 thermal aging hours, and 2,200 power cycles
- No significant decrease in electrical or thermal performance was observed.



Photo by Douglas DeVoto, NREL

Substrates undergoing aging

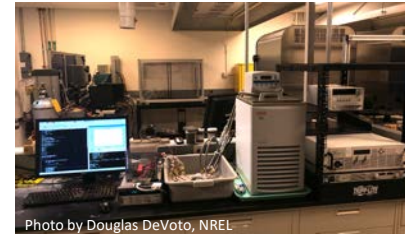
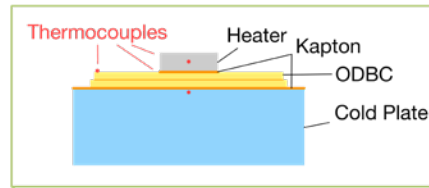
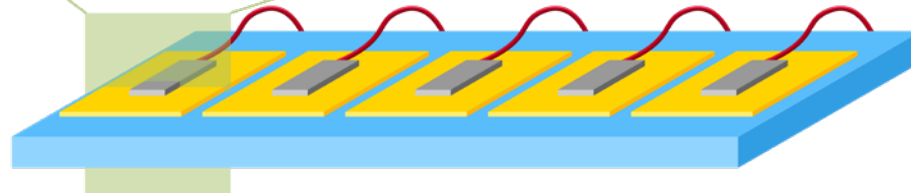


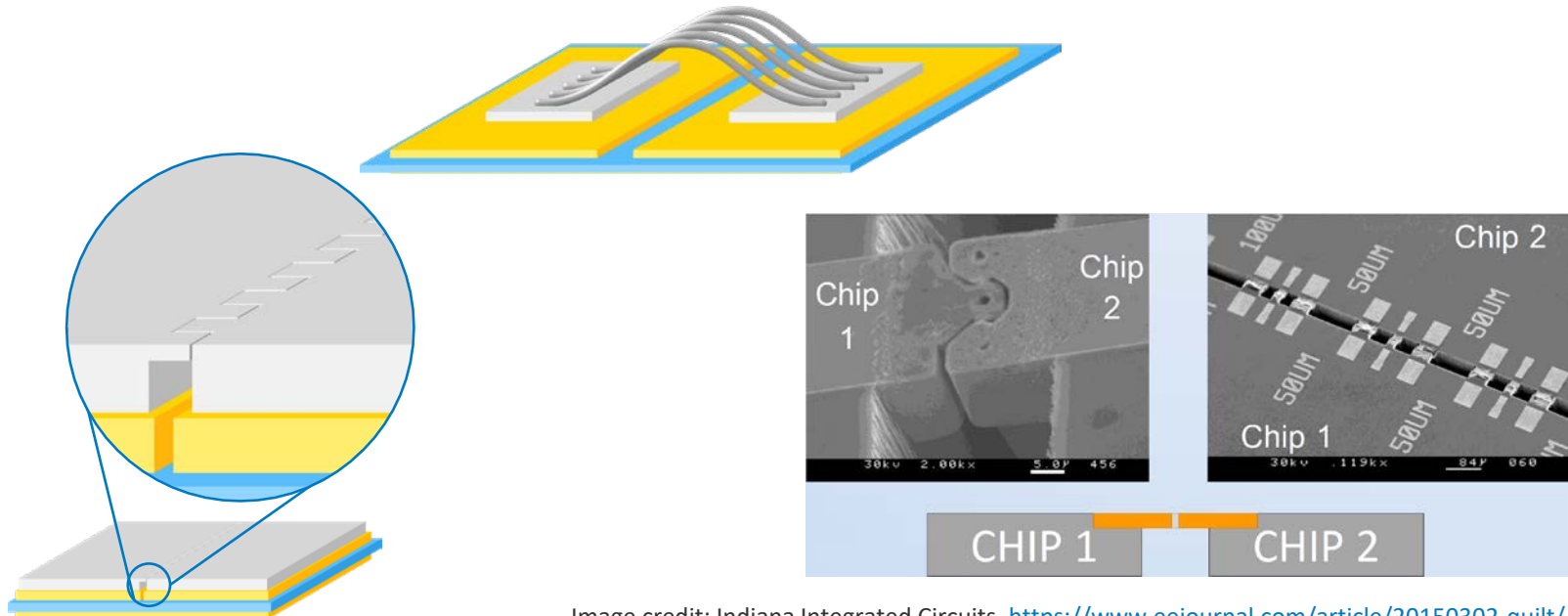
Photo by Douglas DeVoto, NREL



Power cycling test setup

# Electrical Interconnect Research

- Alternative interconnect designs are required as devices are reduced in size and spacing between devices is minimized.
- Traditional wire interconnects or etched substrates for topside electrical connections can be replaced with direct chip-to-chip connection.



# Quilt Packaging Reliability Experimental Evaluation

- Evaluated quilt packaging samples under thermal cycling and vibration experiments
  - *Sinusoidal vibration*: 20-Hz to 1,000-Hz sweep, 5-g acceleration, 2-hour duration (IEC 60068-2-6)
  - *Mechanical shock*: half-sine pulse, 30-g acceleration, 18-ms duration, repeating three times (IEC 60068-2-27)
  - *Thermal cycling*:  $-40^{\circ}\text{C}$  to  $150^{\circ}\text{C}$ ,  $10^{\circ}\text{C}/\text{min}$  ramp rate, 15-min soak, 1,000 cycles (JESD22-A104D).
- Electrical resistance measurements increased significantly for all samples subjected to mechanical shock and thermal cycling tests.

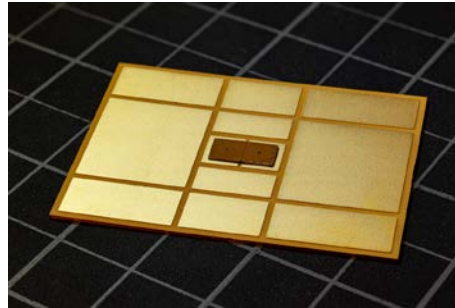
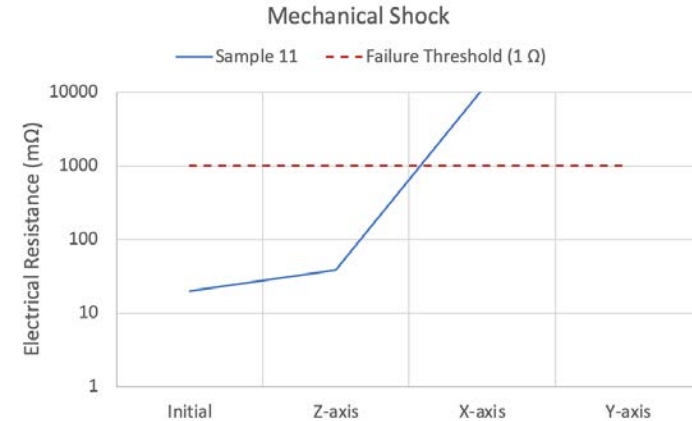


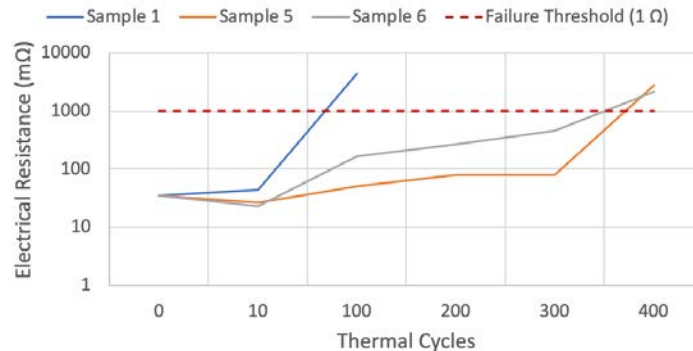
Image credit: Doug DeVoto

Indiana Integrated Circuits package on Dupont ODBC substrate

## Nodule electrical resistance



## Thermal Cycling





# Thermal Management of Electric Machines and Integrated Electric Drive Systems

Sreekant Narumanchi

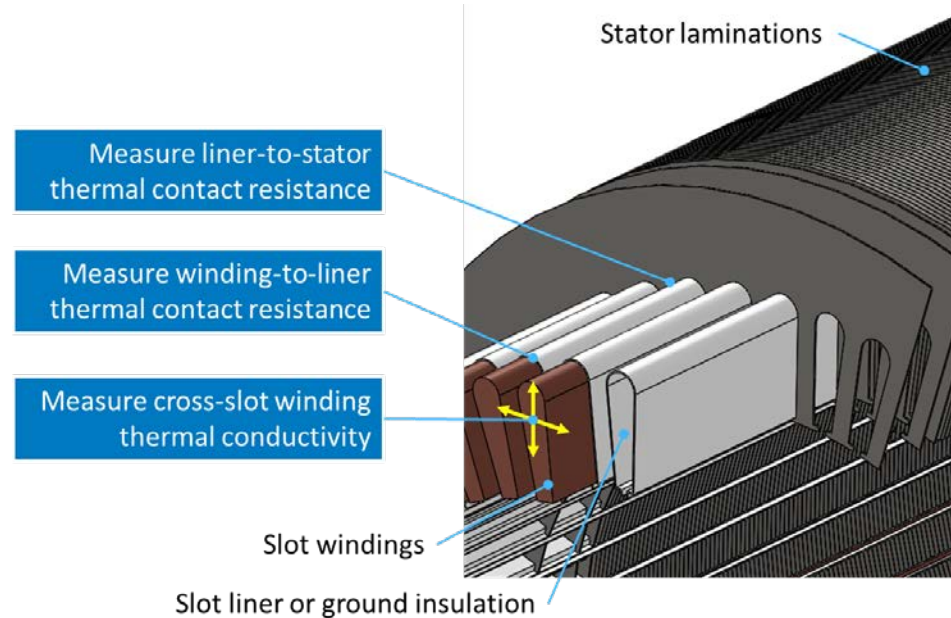


# Electric Motor Thermal Management

- Understand and evaluate material and interface properties as a function of temperature.
- Develop and evaluate advanced fluid-based cooling strategies.
- Use modeling to guide advanced motor design and development.



Image credits: Bidzina Kekelia, NREL



# Automatic Transmission Fluid Jet Impingement

Direct impingement cooling for motor windings

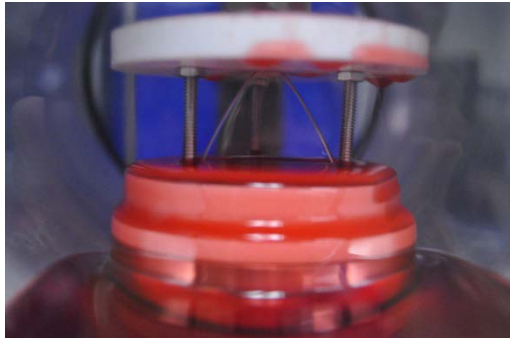
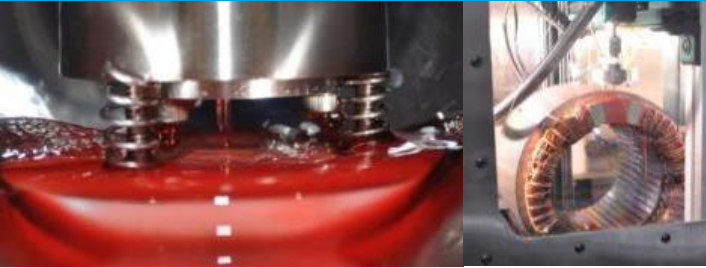
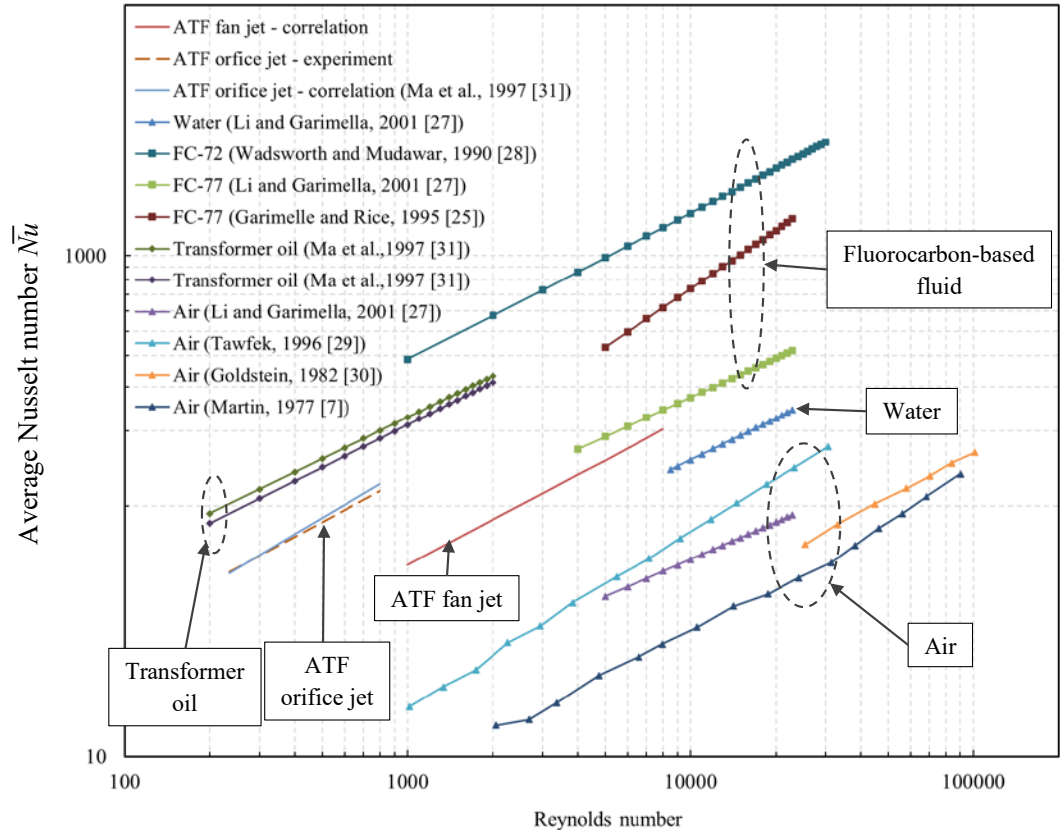
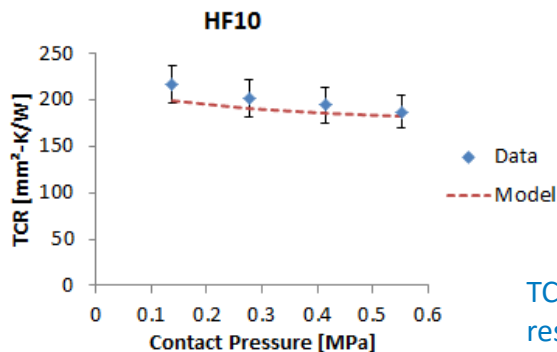
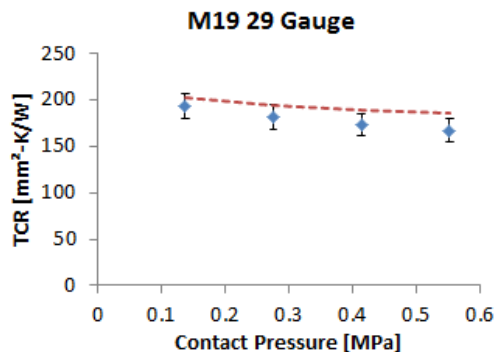
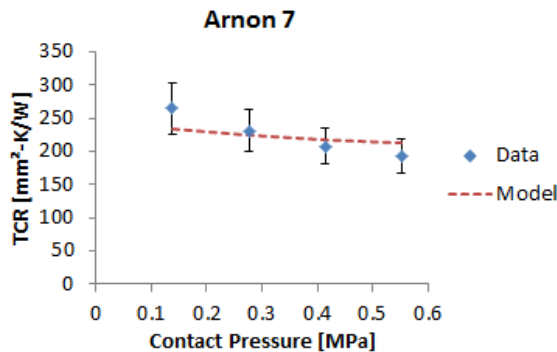
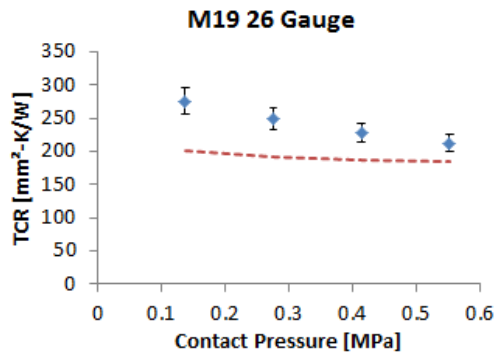


Image credits: Bidzina Kekelia and Xuhui Feng (NREL)



# Motor Lamination Thermal Contact Resistance



- Validated model with experimental data using multiple materials.

- $R_{air} = \delta/k_{air}$   
 $\delta = 1.53\sigma_{RMS}(P/H)^{-0.097}$   
 $R_C = (\delta + t_{C5})/k_{air}$

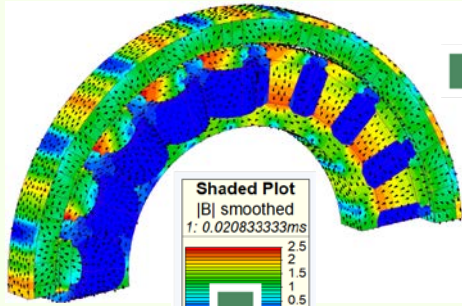
TCR: thermal contact resistance

# Electric Motor Modeling and Design

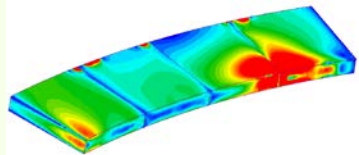
Electromagnetic, mechanical, and thermal design

## Oak Ridge National Laboratory (ORNL)

Electromagnetic design

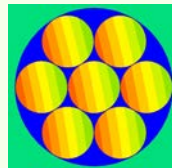
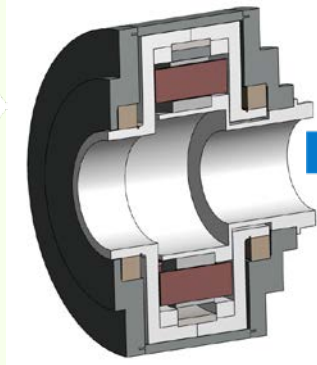


Loss evaluation



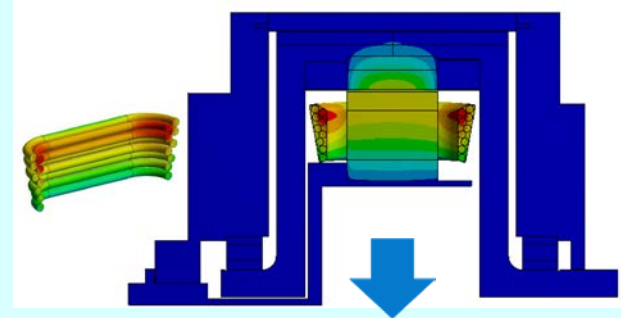
PM eddy current loss

Mechanical assembly design

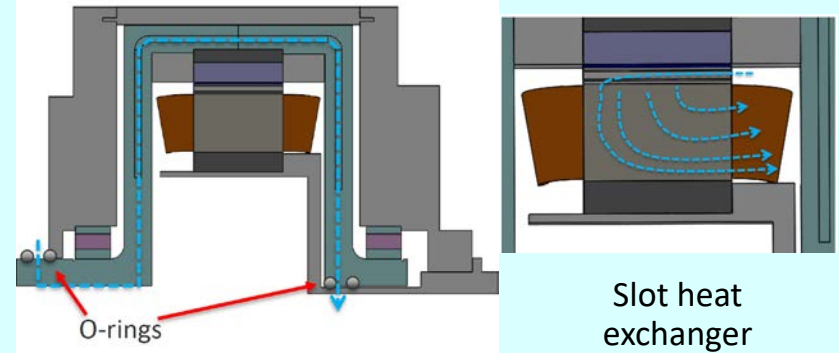


AC loss in Litz  
wire winding

## NREL and Georgia Tech Thermal modeling



Cooling design

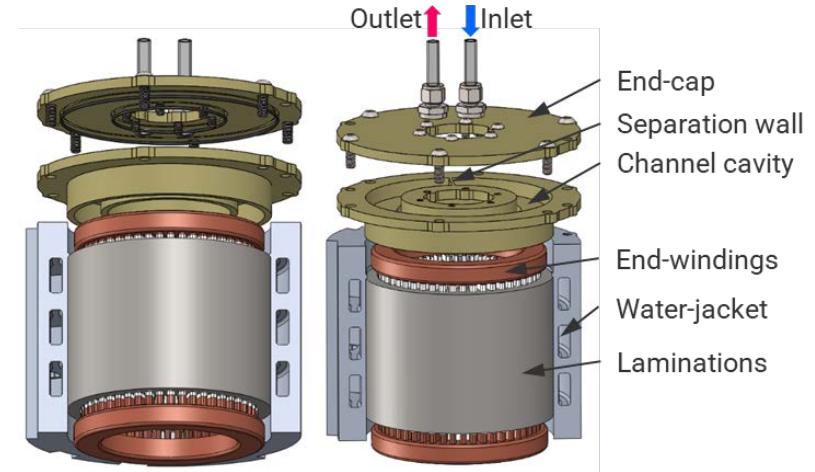


Rotor cooling

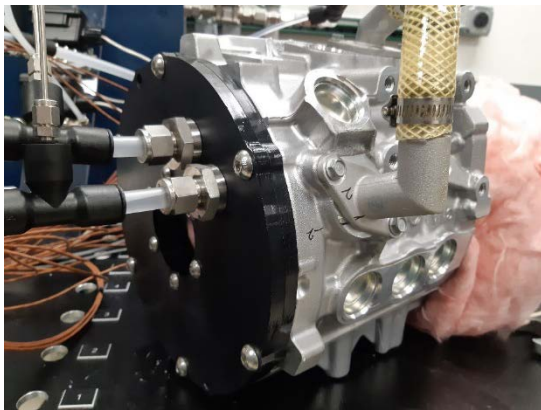
Slot heat  
exchanger

# Experimental Validation of Motor Cooling Concept

- Advanced thermal management designs are critical to enable increased motor power density to meet DOE targets (50 kW/L).
- Collaboration between Georgia Tech and NREL.
- Cooling technology demonstrated a 30%–45% decrease in motor end-winding temperatures relative to the baseline commercial electric vehicle motor.



Section view of proposed motor end-winding cooling concept.



Assembled motor end-winding cooler at NREL (Photo credit: Sebastien Sequeira, Georgia Tech and NREL).

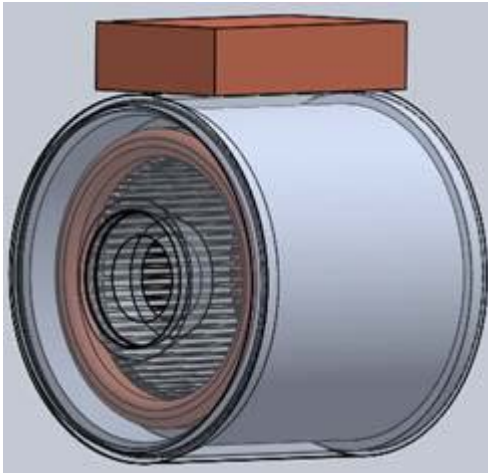


# Integrated Electric Drive Thermal Management

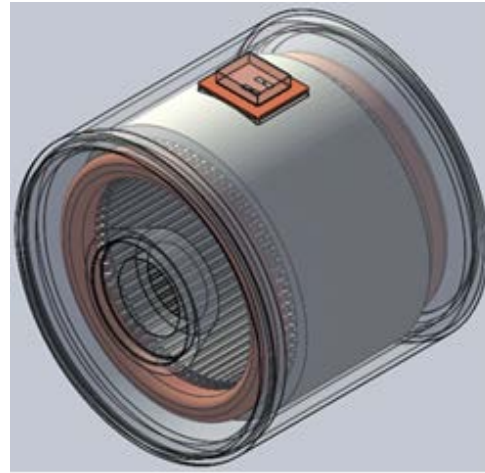
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# Integrated Traction Drive System

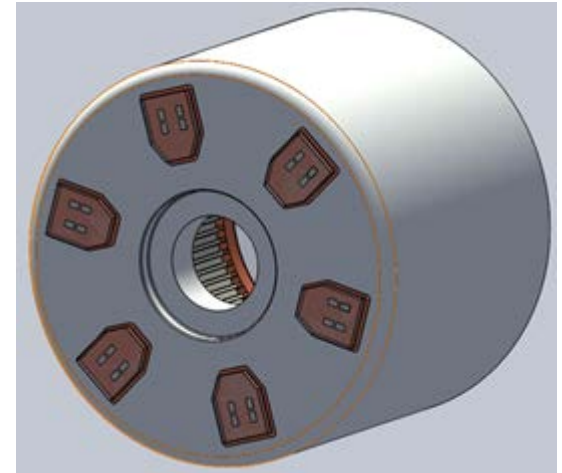
## Different integration techniques



Separate enclosures



Radial integration

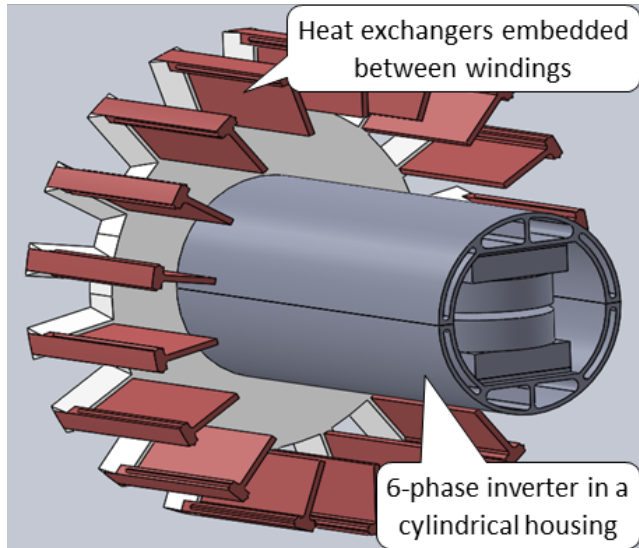


Axial integration

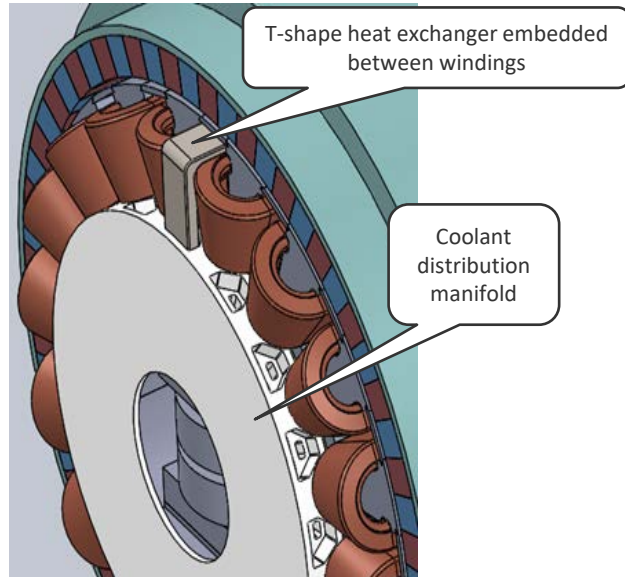
# Integrated Traction Drive Thermal Management

- ORNL and NREL collaboration

- Completed several design revisions of T-shaped heat exchanger embedded between winding phases.
- Completed several design revisions for coolant distribution manifold-disk.
- Completed several revisions for cylindrical inverter housing.

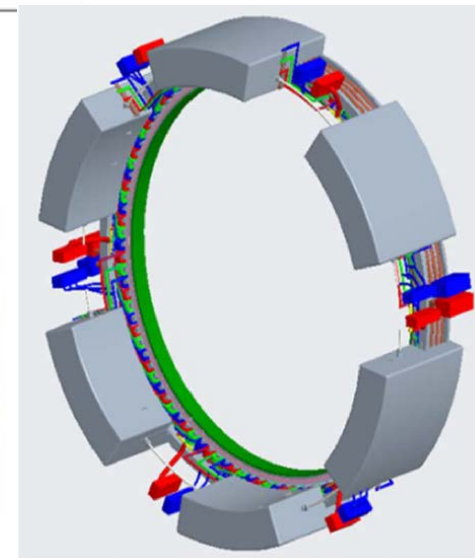
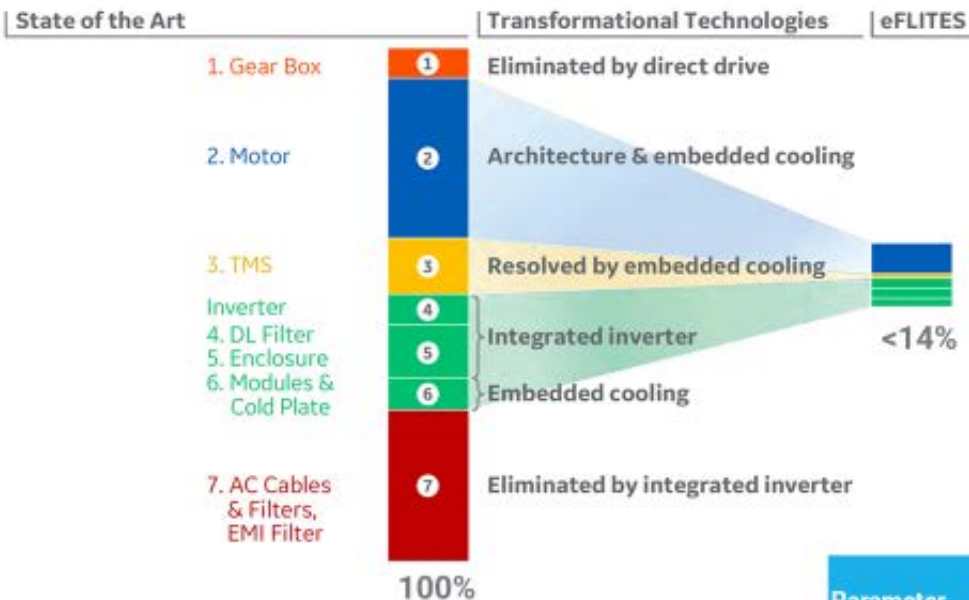


Key components of thermal management system for ORNL's outer-rotor integrated drive.



General view of thermal management system assembly for ORNL's outer-rotor integrated drive.

# Integrated Electric Drive and Thermal Management for Aviation



**Co-design / Integration & Cooling Technologies vital to power density increase**

Parameter	Performance Metric	
	State-of-the-Art	eFLITES
Power Density [kW/kg]	~1.5	>10
Take-off & Climb Efficiency [%]	87+	94

## Acknowledgments

U.S. Department of Energy

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# Thank You

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